3.2 A Dual Input, Switch Mode Charger with Power Path

Description

The FAN5451x family of chargers includes an I^2C controlled 3.2 A USB-compliant switch-mode charger.

To facilitate fast system startup, the IC includes an optimized Power Path circuit which also accurately measures battery currents during charging and provides low impedance during discharge.

The charging parameters and operating modes are programmable through an I²C Interface. Charge status is reported back to the host through the I²C port and the / STAT pin.

The FAN5451x provides battery charging in three modes: Pre-Charge (IPP), Constant Current (CC) and Constant Voltage (CV). The charger can automatically restart the charge cycle when the battery falls below a restart voltage threshold. If the input source is removed, the IC enters a high-impedance mode, blocking battery current from leaking to either input.

The FAN5451x is available in a 63-bump, 0.4 mm pitch WLCSP package.

Features

- Fully Integrated, High-Efficiency Charger for Single-Cell Li-Ion and Li-Polymer Battery Packs
- Power Path Circuit ensures Fast System Startup with a Dead Battery
- 95% Charge Efficiency
- Charge Current Programmable up to 3.2 A
- 10 mV Float Voltage Accuracy
- ±5% Charge Current Regulation Accuracy
- 5 V, 1.5 A Boost Mode for USB OTG
- 22 V DC Withstand Voltage on VBUS
- 13.25 V Maximum Input Operating Voltage
- -2 V Input Reverse Polarity Protection

Benefits

- Secondary Input for Wireless Charging
- Dynamic Input Voltage Control (DIVC) for Operation with Weak Adapters
- USB BC1.2 Compatible
- Programmable 10 mA LDO
- Programmable Safety Timer with Reset Control
- Pin Configurable Ship Mode prevents Battery Discharge to System Load

Applications

- Smart Phones
- Tablets



www.onsemi.com



Figure 1. Typical Application

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

- Pin or Software Configurable Hardware Reset for Quick System Restart
- Battery Temperature Sensing Ensures Safe-To-Charge Operation (JEITA)
- Thermal Shutdown and Programmable Thermal Regulation
- High–Speed I²C Interface (3.4 Mb/s) with Fast Mode Plus Compatibility
- e-Books
- Li Ion Powered Devices

Table 1. ORDERING INFORMATION

| Part Number | Package | Packing Method |
|---------------|---|----------------|
| FAN54510AUCX | 63 – Bump, Wafer-Level Chip_Scale Package (WLCSP) | Tape and Reel |
| FAN54511AUCX | 0.4 mm Pitch | |
| FAN54511APUCX | | |
| FAN54512AUCX | | |
| FAN54513AUCX | | |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Table 2. DEVICE ORDERING INFORMATION

| Part Number | Slave Address | PN Bits: IC_INFO[5:3] | BC1.2 Detection | BC1.2 SDP I _{BUS} Current Limit | BC1.2 CDP/DCP I _{BUS} Current Limit | ILIM Pin Control | I _{BUS} Current Limit (ILIM Pin = HIGH) | I _{BUS} Current Limit (ILIM Pin = LOW) |
|-----------------------|------------------|------------------------------|--------------------|---|--|------------------------|---|--|
| FAN54510A (Note 1) | 1101011_ | 000 | ON (D+, D–) | 2 min. @500 mA | Safety Timer @1500 mA | OFF | N/A | N/A |
| FAN54511A | 1101011_ | 001 | OFF (GPO1,GPO2) | N/A | N/A | ON | 500 mA | 1500 mA |
| FAN54511AP | 1101010_ | 001 | OFF (GPO1,GPO2) | N/A | N/A | ON | 500 mA | 1500 mA |
| FAN54512A (Note 1) | 1101011_ | 010 | ON (D+, D–) | 45 min. @100 mA | Safety Timer @1500 mA | OFF | N/A | N/A |
| FAN54513A | 1101011_ | 011 | OFF (GPO1,GPO2) | N/A | N/A | ON | 100 mA | 1500 mA |

1. Contact ON for these options.

STATE DIAGRAMS



Figure 2. Charger State Diagram: State and Mode Transitions



Figure 3. Charger State Diagram: Charger/Battery/System Protection



Figure 4. Boost State Diagram



BLOCK DIAGRAM AND SYSTEM DIAGRAMS

Figure 5. Block Diagram







Figure 7. FAN54511A, FAN54511AP, FAN54513A System Diagram

RECOMMENDED EXTERNAL COMPONENTS

| Component | Description | Vendor | Parameter | Тур. | Unit |
|---|---|--|-----------|------|------|
| L1 | 1.0 μH, +20/–10%, 4.1 A, 2520 x | SEMCO CIGT252010EH1R0MNE | L | 1.0 | μH |
| | 1.0 mm | SEMCO CIGT2520TOERTROMINE | DCR | 26 | mΩ |
| C _{BAT} (Note 2) | 22 μF, 6.3 V, 20%, X5R, 0603 | TDK C1608X5R0J226M | С | 22 | - |
| C _{MID} x 2 (Note 3) | 10 μF, 25 V, 10%, X5R, 0805 | Murata GRM219R61E106M | С | 10 | μF |
| C _{BUS,} C _{IN} | 1.0 μF, 25 V, 10% X5R, 0603 | Murata GRM188R61E105K TDK: C1608X5R1E105M | С | 1.0 | nF |
| C _{SYS} (Note 4) | 10 μF, 6.3 V, 20%, X5R, 0603 | Murata GRM188R60J106M | С | 10 | |
| C _{REF,} C _{REG} , C _{LDO} | 1.0 μF, 10 V, 20%, X5R, 0402 | Murata GRM155R61A105M | С | 1.0 | μF |
| C _{BOOT} | 10 nF, 10 V, 10%, X7R, 0201 Murata GRM033R71A103K | | С | 10 | |
| R _{REF} | 10 kΩ | | R | 10 | kΩ |
| R _{PU} | 1 MΩ | | R | 1 | MΩ |

2. A minimum effective capacitance of 3.6 µF is required after accounting for tolerance, temperature, and aging.

3. A minimum effective capacitance of 8 µF is required after accounting for tolerance, temperature, and aging.

4. Including CSYS, a minimum effective system capacitance (distributed) of 20 μF after accounting for tolerance, temperature, and aging is required.



Top View



Bottom View

Figure 8. WLCSP-63 Pin Assignments

Table 4. PIN DEFINITIONS

| Pin # | Name | lame Type Description | | | | |
|---------------------------------|---|-----------------------|---|--|--|--|
| POWER GROUND (LC | POWER GROUND (LOCAL PGND) REFERENCED PINS | | | | | |
| A1, B1 | VIN | Р | Wireless Charger Input Voltage. From wireless receiver or second input power source. Bypass VIN to PGND with 1 $\mu\text{F}.$ | | | |
| C1, D1 | VBUS | Р | Charger Input Voltage. USB adapter input source also used for the USB–OTG output voltage. Bypass VBUS to PGND with 1 $\mu\text{F}.$ | | | |
| A2, A3, A5, B2–B5, C2–C5, D2 | PMID | PFP | Power Input Voltage. Power input to the charger regulator, bypass point for the input current sense. Bypass PMID to PGND locally with a minimum of $2x C_{MID}$. | | | |
| A6, B6, C6, D6 | SW | Р | Witching Node. Connect to inductor L1 and CBOOT. | | | |
| A4 | BOOT | Р | Bootstrap. High side NMOS Driver Bias. Connect a 10 nF capacitor between BOOT and SW. | | | |
| E7, F5–F7 | SYS | Р | System Supply. Connect system load here. Bypass SYS to PGND locally with $\mathrm{C}_{\mathrm{SYS}}.$ | | | |
| G5–G7, H7 | BAT | Р | Battery Voltage. Connect to the positive (+) terminal of the battery pack. Bypass BAT to PGND with C_{BAT} . | | | |
| E1 | LDO | AO | Linear Regulator. LDO is for powering external circuitry. Default output is 4.95 V when VBUS or VIN is valid. | | | |
| A7, B7, C7, D7 | PGND | PG | Power Ground. Power return for gate drive and power transistors. The connection from these pins to the ground pads of $C_{\rm MID}$ and $C_{\rm SYS}$ should be as short as possible. Refer to Recommended Component Placement. | | | |

ANALOG GROUND (AGND) REFERENCED PINS

| E2 | REG | AFP | Internal Regulator. Bypass with a 1 μF capacitor to AGND |
|--|--------|------|--|
| G1 | BATSNS | AI | Battery Voltage Sense. Connect this pin as close to battery terminal as possible using a single trace. Do not use as a power pin. |
| H1 | REF | AO | Reference Voltage. REF is a 1.8 V regulated output used in conjunction with the NTC pin to determine the battery temperature. Connect to a 1 μF capacitor to AGND. |
| J2 | NTC | AI | Negative Temperature Coefficient Resistor. Pin is connected to the NTC terminal of the battery pack with a 10 k Ω external pull–up resistor to the REF pin. Note: Other values of the pull/up resistor and NTC may be used. See applications section for more detail. |
| D5, E3–E6, F1–F3, G2, G3, H2, H3, J1, J7 | AGND | AGND | Analog Ground. All IC signals are referenced to this node. Connect to PGND at a single point. Refer to Recommended Component Placement. |

SYSTEM GROUND (PGND) REFERENCED PINS

| | D+ AI/O Positive USB data line (FAN54510A, FAN54512A only). Used for BC tion of SDP, DCP, or CDP device connection. | | Positive USB data line (FAN54510A, FAN54512A only). Used for BC1.2 adapter detec- tion of SDP, DCP, or CDP device connection. |
|------------|---|------|--|
| | | DO | General Purpose Output 1 (FAN54511A, FAN54511AP, FAN54513A only). CMOS output driver that is sourced from the LDO output. |
| | D- | AI/O | Negative USB data line (FAN54510A, FAN54512A only). Used for BC1.2 detection of SDP or DCP/CDP device connection. |
| (2009) 100 | | DO | General Purpose Output 2 (FAN54511A, FAN54511AP, FAN54513A only). CMOS output driver that is sourced from the LDO output |
| F4 | SDA | DI/O | I ² C Interface Serial Data. Open-drain, Bi-directional I ² C serial data line. This pin should not be left floating. |
| G4 | SCL | DI | I ² C Interface Serial Clock. I ² C communication clock input. This pin should not be left floating. |
| H4 | ILIM | DI | Input Current Limit for VBUS (FAN54511A, FAN54511AP, FAN54513A only). Input LOW sets the input current limit to 1.5 A and HIGH sets to 500 mA (FAN54511A, FAN54511AP only) or 100 mA (FAN54513A only). This pin is internally pulled down through a 1 M Ω resistor. |
| | | | ILIM pin functionality is disabled for FAN54510A and FAN54512A versions where it is recommended to tie ILIM to AGND or PGND. |

| H5 | /SHIP | DI | Ship Mode Enable (Active–Low). If this pin is held LOW for more than $t_{SHIPENTER}$ during any other state, Ship Mode is entered and the battery is fully isolated from the system load. If /SHIP is held LOW again for more than $t_{SHIPEXIT}$, Ship mode is disabled and Q4 is configured to allow the battery to discharge to the system load. Ship mode can also be exited, automatically, by applying a valid input source. Tie this pin to BAT using a 1 M Ω pull–up resistor for devices with embedded batteries. |
|----|--------|----|--|
| H6 | /INOK | DO | VIN Power Okay (Active–Low). Active low, open–drain output indicates that the input source voltage at VIN has risen above V _{SOURCE(RISE)} and passed validation, and a valid VBUS is not present. /INOK remains low while V _{IN (FALL)} < V _{IN} < V _{INOVP} and V _{IN} > V _{BAT} . /INOK will be HIGH if /BUSOK is LOW. |
| J4 | /STAT | DO | Status (Active–Low). Open–drain output indicating charge status. The IC pulls this pin LOW when charging is in progress, and can be used to signal the host processor or drive an LED. |
| J5 | /BUSOK | DO | VBUS Power Okay (Active–Low). Active low, open–drain output indicates that the input source voltage at VBUS has risen above $V_{SOURCE(RISE)}$ and passed validation. /BUSOK remains low while V_{BUS} (FALL) < V_{BUS} < V_{BUSOVP} and V_{BUS} > V_{BAT} . |
| J6 | /INT | DO | Interrupt (Active–Low). Active low, open–drain output indicates that an interrupt bit or bits have been set. This pin is reset to HIGH after all set interrupt register bit(s) are read. This pin is not pulled LOW when an interrupt occurs that is masked by the associated mask bit. |
| J3 | DIS | DI | Disable. If this pin is held HIGH, the PWM converter is disabled, creating a high impedance path between VBUS/VIN and SYS. This pin has an internal 1 M Ω pull-down. |

5. Pin Types-A = Analog, D = Digital, P = Power, I = Input, O = Output, G = Ground, FP = Filter Point

ABSOLUTE MAXIMUM RATINGS

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Parameter | Min | Max | Unit | | |
|------------------|---|---------------------------|------|-----------------|----|--|
| | VBUS, PMID Voltage, Maximum Slew Rate of 2 | V/µs (Note 6) | -2.0 | 22.0 | | |
| | VIN Voltage, Maximum Slew Rate of 2 V/ μ s (Not | e 6) | -2.0 | 16.0 | | |
| | BOOT Voltage | | -0.3 | 19.0 | | |
| V_{DC} | | DC | -0.3 | 14.0 | | |
| | SW Voltage | Transient: < 5 ns | -1.0 | 17.0 | V | |
| | SYS, BAT Voltage | | -0.3 | 6.5 (Note 7) | | |
| V _{DCO} | Voltage on Other Pins | | -0.3 | 6.5 (Note 7) | | |
| | Electrostatic Discharge Protection Level, HBM | VBUS, PMID, VIN, BOOT, SW | 1250 | | | |
| ESD | per JESD22-A114 | All Other Pins | 2000 | | v | |
| LOD | Electrostatic Discharge Protection Level, CDM per JESD22–C101 | All Pins | 15 | 600 | | |
| TJ | Junction Temperature | -40 | +150 | °C | | |
| T _{STG} | Storage Temperature | | | +150 | °C | |
| TL | Lead Soldering Temperature, 10 Seconds | | | +260 | °C | |

6. Positive slew rate applies only to voltages above the VIN_OVP or VBUS_OVP threshold.

7. Lesser of 6.5 V or V_{BAT} + 0.3 V.

RECOMMENDED OPERATING CONDITIONS

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. On Semiconductor does not recommend exceeding them or designing to Absolute Maximum Ratings.

Table 6. RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | | Min. | Max. | Unit |
|-----------------------------------|--|------|-------|------|------|
| V _{BUS,} V _{IN} | Supply Voltage | 4.50 | 13.25 | V | |
| T _A | Ambient Temperature | -30 | +85 | °C | |
| TJ | Junction Temperature | -30 | +100 | °C | |
| C _{BAT} | Minimum Effective Capacitance on VBAT | 3.6 | | μF | |
| C _{MID} | Minimum Effective Capacitance on PMID | 8 | | μF | |
| C _{SYS_DISTRIBUTED} | Minimum Effective Capacitance on SYS (inclustributed system capacitance) | 20 | | μF | |
| C _{LDO} | Minimum Effective Capacitance on LDO | 0.4 | | μF | |
| C _{REG} | Minimum Effective Capacitance on REG | | 0.4 | | μF |

THERMAL PROPERTIES

Junction-to-ambient thermal resistance is a function of application and board layout. This data is measured with four-layer 2s2p boards without vias in accordance to

JEDEC standard JESD51. Special attention must be paid not to exceed junction temperature $T_{J(max)}$ at a given ambient temperature T_A .

Table 7. THERMAL PROPERTIES

| Symbol | Parameter | Typical | Unit |
|---------------|---|---------|------|
| θ_{JA} | Junction-to-Ambient Thermal Resistance | 40 | °C/W |
| Ψ_{JB} | Junction-to-Board Thermal Characterization Parameter (Evaluation Board) | 4.3 | °C/W |

Table 8. ELECTRICAL SPECIFICATIONS

Unless otherwise specified: V_{BUS} = 5.0 V; V_{BAT} = 3.7 V; HZMODE = "0"; BOOSTEN = "0" (Charge Mode); TREGTH = 120°C; I_{REG} = I_{LDO} = 0 A; SCL, SDA = 0 or 1.8 V; and typical values are for T_A = 25°C

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|---------------------|--|--|------|------|------|------|
| POWER SUPPLI | ES | | | • | | |
| | | V _{BUS} > V _{SOURCE(RISE)} ; V _{IN} Open; PWM Switching; I _{BAT} = I _{SYS} = 0 A | | 4 | | mA |
| ISOURCE | V _{BUS} or V _{IN} Current | V _{IN} > V _{SOURCE(RISE)} ; V _{BUS} Open; PWM Switching; I _{BAT} = I _{SYS} = 0 A | | 4 | | mA |
| | | HZMODE= "1"; V _{SOURCE} > V _{SOURCE(RISE)} , NTC = GND | | 200 | 400 | μA |
| | | Sleep State; $V_{BUS} = V_{IN} = Open \text{ or } 0V;$ $V_{BAT} = 4.2 \text{ V}$ | | 3 | 10 | μA |
| | | Ship Mode State; $V_{BUS} = V_{IN} = Open$ or 0 V; $V_{BAT} = 4.2 V$ | | 0.8 | 10 | μA |
| I _{BAT_HZ} | Battery Discharge Current | $\begin{array}{l} \text{DIS}=\text{HIGH or HZMODE="1";} \\ \text{V}_{\text{BUS}}\text{=}5 \text{ V; } \text{V}_{\text{IN}}\text{=}\text{Open; } \text{V}_{\text{BAT}}\text{=}4.2\text{V ;} \\ \text{I}_{\text{SYS}}\text{=}0\text{ A} \end{array}$ | | 1 | 10 | μA |
| | | DIS = HIGH or HZMODE ="1"; V_{BUS} = Open; V_{IN} = 5V; V_{BAT} = 4.2V; I_{SYS} = 0 A | | 1 | 10 | μΑ |
| | Battery Leakage Current to V _{BUS} in High-Impedance Mode | V_{BUS} = 0 V; V_{IN} = Open; V_{BAT} = 4.2 V; I_{SYS} = 0 A | | 0.2 | 5.0 | μA |
| ISOURCE_HZ | Battery Leakage Current to V _{IN} in High-Impedance Mode | V_{IN} = 0 V; V_{BUS} = Open; V_{BAT} = 4.2 V; I_{SYS} = 0 A | | 0.2 | 5.0 | μΑ |

CHARGER VOLTAGE REGULATION

| V _{FLOAT} | Charge Voltage Range | | 3.30 | 4.72 | V |
|--------------------|-------------------------|--|------|----------|----|
| | Charge Voltage Accuracy | $T_J = 25^{\circ}C; V_{FLOAT} = 4.20 V \text{ to } 4.50 V$ | -6 | +6 | |
| | | T_J = 0 to 70°C; V_{FLOAT} = 4.20 V to 4.50 V | -10 | +10 | mV |
| | | $T_J = -25$ to 85°C; $V_{FLOAT} = All Settings$ | -25 | +25 | |

FAST CHARGE CURRENT REGULATION

| | Output Charge Current Range | V _{BATMIN} < V _{BAT} < V _{FLOAT} | 200 | 3200 | mA |
|--------|-----------------------------|--|-----|------|----|
| IOCHRG | | $I_{OCHRG} \ge 500 \text{ mA}, -30^{\circ}\text{C} < T_A < 85^{\circ}\text{C}$ | -5 | +5 | % |
| | Charge Current Accuracy | I _{OCHRG} < 500 mA, –30°C <t<sub>A< 85°C</t<sub> | -10 | +10 | 70 |

PRE-CHARGE CURRENT CONTROL

| I _{pp} | Pre-Charge Current Range | | 200 | | 800 | mA |
|--------------------|-----------------------------|---------------------------------------|-----|----|-----|----|
| | Pre-Charge Current Accuracy | | -15 | | +15 | % |
| I _{SHORT} | Linear Charging Current | V _{BAT} < V _{SHORT} | 45 | 55 | 65 | mA |

Table 8. ELECTRICAL SPECIFICATIONS (continued)

Unless otherwise specified: $V_{BUS} = 5.0 \text{ V}$; $V_{BAT} = 3.7 \text{ V}$; HZMODE = "0"; BOOSTEN = "0" (Charge Mode); TREGTH = 120°C; $I_{REG} = I_{LDO} = 0 \text{ A}$; SCL, SDA = 0 or 1.8 V; and typical values are for $T_A = 25^{\circ}C$

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|-----------------------------|---|---|------|------|------|------|
| CHARGE TERMI | NATION DETECTION | • | • | • | • | • |
| | Termination Current Threshold Range | V _{BAT} > V _{FLOAT} - V _{RCHG} ; V _{BUS} > V _{BAT} | 25 | | 600 | mA |
| ITERM | Termination Current Threshold | ITERM Setting > 200 mA | -10 | | +10 | |
| TERM | Accuracy | ITERM Setting = 100 mA to 200 mA | -20 | | +20 | % |
| | Termination Current Deglitch Time | | | 30 | | ms |
| WEAK BATTERY | DETECTION | - | • | • | | |
| | Weak Battery Threshold Range | | 3.0 | | 3.7 | V |
| | Lhuterezia | FAN54512A Only | | 100 | | |
| V _{LOWV} | Hysteresis | All Other Part Numbers | | 3 | | mV |
| | Termination Current Threshold Accuracy | | -5 | | +5 | % |
| | Weak Battery Deglitch Time | Rising Voltage; 2 mV Overdrive | | 30 | | ms |
| MINIMUM BATTE | RY VOLTAGE DETECTION | • | • | • | • | • |
| | Pre-charge to Fast Charge Transition Threshold Range | | 2.7 | | 3.4 | V |
| V _{BATMIN} | Hysteresis | | 180 | 265 | 350 | mV |
| | Threshold Accuracy | | -5 | | +5 | % |
| | Deglitch Time | | | 30 | | ms |
| BATTERY RECH | ARGE THRESHOLD | • | | | | |
| V | Recharge Threshold | Below V_{FLOAT} ; $T_J = 25^{\circ}C$ | | 170 | | mV |
| V _{RCHG} | Deglitch Time | V_{BAT} falling below V_{RCHG} threshold | | 130 | | ms |
| SHORTED BATT | ERY THRESHOLD | | | | | |
| V _{SHORT} | Battery Short-Circuit Threshold | V _{BAT} Rising | 1.94 | 2.00 | 2.06 | V |
| BATTERY FET S | UPPLEMENTAL CONTROL | | | | | |
| M | BAT to SYS Threshold for BATFET | $V_{SYS -} V_{BAT,}$ Falling V_{SYS} | -6 | -5 | -4 | |
| V _{THSYS} | Gate transition while charging | V _{SYS –} V _{BAT,} Rising V _{SYS} | 0 | 1 | 2 | mV |
| BATTERY TEMP | ERATURE DETECTION | | | | | |
| T1 | T1 (0°C) Temperature Threshold | | 71.9 | 73.9 | 75.9 | |
| T2 | T2 (10°C) Temperature Threshold | | 62.6 | 64.6 | 66.6 | % of |
| Т3 | T3 (45°C) Temperature Threshold | | 30.9 | 32.9 | 34.9 | VREF |
| T4 | T4 (60°C) Temperature Threshold | | 21.3 | 23.3 | 25.3 | 1 |
| V _{JEITA} (Note 9) | FLOAT Voltage Reduction During JEITA Region | V _{FLOAT} = 4.35 V | 160 | 200 | 240 | mV |
| | 1 | | | | | |

Table 8. ELECTRICAL SPECIFICATIONS (continued)

Unless otherwise specified: $V_{BUS} = 5.0 \text{ V}$; $V_{BAT} = 3.7 \text{ V}$; HZMODE = "0"; BOOSTEN = "0" (Charge Mode); TREGTH = 120°C; $I_{REG} = I_{LDO} = 0 \text{ A}$; SCL, SDA = 0 or 1.8 V; and typical values are for $T_A = 25^{\circ}C$

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|---------------------------|---|---|------|------|------|------|
| INPUT POWER S | OURCE DETECTION | - | | | | |
| V _{SOURCE(RISE)} | $\rm V_{BUS}$ or $\rm V_{IN}$ Input Voltage Rising | To Initiate Source Validation | 4.30 | 4.40 | 4.52 | V |
| V _{SOURCE(FALL)} | Minimum V_{BUS} or V_{IN} | During Charging, V _{BAT} < 3.6 V | 3.55 | 3.70 | 3.80 | V |
| V _{SLP} | Sleep–Mode Entry Threshold, V _{SOURCE} – V _{BAT} | $V_{SOURCE(FALL)} \leq V_{BAT}$ | 0 | 40 | 100 | mV |
| t _{SRCQUAL} | $V_{BUS} \text{ or } V_{\text{IN}}$ Input Qualification Time | | | 32 | | ms |
| tvsc_valid | $V_{BUS} \text{ or } V_{\text{IN}}$ Input Validation Time | | | 32 | | ms |
| IVSOURCE | $V_{BUS} \text{ or } V_{\text{IN}}$ Input Validation Current | | | 50 | | mA |
| DIVC CONTROL | LOOP | • | * | • | • | |
| IVSOURCE | $V_{BUS} \text{ or } V_{\text{IN}}$ Input Validation Current | | | | | |

| V _{SOURCE(LIM)} Input Voltage Loop Setpoint Accuracy | | -3 | | +3 | % | |
|--|--|----|--|----|---|--|
|--|--|----|--|----|---|--|

INPUT CURRENT LIMIT

| | V _{BUS} Input Current Limit Range | | 100 | | 3000 | |
|---------------------|--|--|------|------|------|----|
| I _{BUSLIM} | V _{BUS} Input Current Limit Threshold | ILIM = HIGH (100 mA) FAN54513A Only | 86 | 93 | 100 | |
| | | ILIM = HIGH (500 mA) FAN54511A, FAN54511AP Only | 460 | 480 | 500 | |
| | | ILIM = LOW (1.5 A); FAN54511A, FAN54511AP, FAN54513A Only | 1380 | 1440 | 1500 | mA |
| | | IBUSLIM (REG 14h[6:0]) = "00h" | 86 | 93 | 100 | |
| | | IBUSLIM (REG 14h[6:0]) = "10h" | 460 | 480 | 500 | |
| | | IBUSLIM (REG 14h[6:0]) = "74h" | 2760 | 2880 | 3000 | |
| | VIN Input Current Limit Range | | 325 | | 2000 | |
| I _{INLIM} | V _{IN} Input Current Limit Threshold | INLIM (REG 16h[6:0]) = "1Bh" | 920 | 960 | 1000 | mA |
| | | INLIM (REG 16h[6:0]) = "43h" | 1840 | 1920 | 2000 | |

LOW DROP OUT REGULATOR

| V _{LDOACC} | LDO Voltage Accuracy | $V_{PMID} \ge V_{LDO} + 500 \text{ mV}; I_{LDO} = 1 \text{ mA}$ | -5 | | +5 | % |
|-----------------------------------|---|--|----|-----|----|----|
| I _{LDO} | Current Rating | $V_{PMID} = V_{LDO} + 500 \text{ mV}$ | 10 | | | mA |
| VLDO _{DROP} (Note 10) | Drop Out Voltage | I _{OUT} = 10 mA | | 170 | | mV |
| RLDO _{PD} | LDO Pull Down Resistance when Disabled | LDO Off | | 1.2 | | kΩ |
| IQ _{LDO} | LDO Quiescent Current | LDO On, V _{PMID} = V _{LDO} + 500 mV | | 20 | 40 | μA |
| REG _{LDO} | LDO Load Regulation | $V_{PMID} = V_{LDO} + 500 \text{ mV};$ 10 $\mu A < I_{OUT} \le 10 \text{ mA}$ | | 50 | | mV |

Table 8. ELECTRICAL SPECIFICATIONS (continued)

Unless otherwise specified: $V_{BUS} = 5.0 \text{ V}$; $V_{BAT} = 3.7 \text{ V}$; HZMODE = "0"; BOOSTEN = "0" (Charge Mode); TREGTH = 120°C; $I_{REG} = I_{LDO} = 0 \text{ A}$; SCL, SDA = 0 or 1.8 V; and typical values are for $T_A = 25^{\circ}C$

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|----------------------------------|--|--|------------------------------|------|----------|------|
| GPO1, GPO2 (F | AN54511A, FAN54511AP, FAN54513A | ONLY) | | | - | • |
| V _(OL) | Output Low | I _{SINK} = 5 mA | | | 0.3 | V |
| V _(OH) | Output High | I _{SOURCE} = 5 mA | V _{LDO} – 200 mV | | | v |
| V _{REF} BIAS GEN | IERATOR | | | | | |
| N/ | Bias Regulator Voltage | V _{SOURCE} > V _{SOURCE} (MIN) | | 1.8 | | V |
| V _{REF} | Short-Circuit Current Limit | | | 2.5 | | μA |
| /STAT, /BUSOK | , /INOK, /INT, SDA | | | | | |
| V _(OL) | Output Low | I _{SINK} = 5 mA | | | 0.4 | V |
| I _(OH) | Output High Leakage Current | VDD = 5 V | | | 1 | μA |
| LOGIC LEVELS | S: SDA, SCL, /SHIP, ILIM, DIS | | | | | |
| V _{IH} | High-Level Input Voltage | | 1.05 | | | V |
| V _{IL} | Low-Level Input Voltage | | | | 0.4 | V |
| I _{IN} | Input Bias Current | Input Tied to GND or V _{BUS} | | 0.01 | 1.00 | μA |
| DIS, ILIM | | I | | | | |
| R _{PD} (Note 11) | Pull Down Resistance | | | 1 | | MΩ |
| D+/D- DETECT | ION (FAN54510A, FAN54512A ONLY) | | | | | |
| V _{DP_SRC} | D+ Source Voltage | 0 to 300 μA | 0.5 | 0.6 | 0.7 | V |
| V _{DM_SRC} | D- Source Voltage | 0 to 300 μA | 0.5 | 0.6 | 0.7 | V |
| V _{DAT_REF} | Data Detect Voltage | | 0.25 | | 0.40 | V |
| I _{DP_SRC} | Data Contact Detect Current Source | | 7 | | 13 | μA |
| I _{DP_SNK} | D+ Sink Current | | 25 | | 175 | μΑ |
| I _{DM_SNK} | D- Sink Current | | 25 | | 175 | μΑ |
| V _{LGC_HI} | Logic High Threshold | | 2 | | | V |
| V _{LGC_LO} | Logic Low Threshold | | | | 0.8 | V |
| R _{DM_DWN} | D– Pulldown Resistor | | 14.25 | | 24.80 | kΩ |
| C _{OFF} (Note 9) | D+, D- Off Capacitance | D+, D- = Hi-Z; f = 1 MHz, V _{BIAS} = 0.2 V | | 4 | | pF |
| BATTERY ABS | ENCE DETECTION | 1 | + | | <u>.</u> | • |
| I _{DETECT} (Note 12) | Battery Detection Current before Charge Done (Sink Current) | Begins after Termination Detected and before | | -8 | | mA |

| | | Charge Done (Clink Current) | before | | |
|---|---------------------|-----------------------------|-------------------------------------|-----|----|
| | t _{DETECT} | Battery Detection Time | $V_{BAT} \leq V_{FLOAT} - V_{RCHG}$ | 262 | ms |
| _ | | | | | |

Table 8. ELECTRICAL SPECIFICATIONS (continued)

Unless otherwise specified: V_{BUS} = 5.0 V; V_{BAT} = 3.7 V; HZMODE = "0"; BOOSTEN = "0" (Charge Mode); TREGTH = 120°C; I_{REG} = I_{LDO} = 0 A; SCL, SDA = 0 or 1.8 V; and typical values are for T_A = 25°C

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|---------------------|---|--|------|------|------|------|
| POWER SWITCH | IES | | | | | |
| | Resistance of VBUS Blocking FET (Q3) | VBUS to PMID; I _{BUS} = 300 mA | | 360 | | |
| | | VBUS to PMID; I _{BUS} = 900 mA | | 82 | | |
| | | VBUS to PMID; I _{BUS} = 3000 mA | | 28 | | |
| | Resistance of VIN Blocking FET (Q5) | VIN to PMID | | 135 | | mΩ |
| R _{DS(ON)} | Resistance of Buck High Side FET (Q1) | PMID to SW | | 24 | | |
| | Resistance of Buck Low Side FET (Q2) | SW to GND | | 19 | | |
| | Resistance of BATFET (Q4) | SYS to BAT; VBAT = 4.2 V; I _{OCHG} = 500 mA | | 55 | | |
| | | SYS to BAT; VBAT = 4.2 V; I _{OCHG} = 1.5 A | | 15 | | |

CHARGER PWM MODULATOR

| f _{SW} | Oscillator Frequency | | 1.5 | | MHz | Ī |
|---------------------------|----------------------|---|-----|------|-----|---|
| D _{UTY} (Note 9) | Duty Cycle | 0 | | 99.6 | % | Ī |

BOOST MODE OPERATION (BOOSTEN (REG 1Ch[5]) = OTG (REG 1Ch[6]) = "1")

| | Programmable Boost Output Voltage Range | 2.5 V < V _{BAT} < 4.5 V | 4.940 | | 5.347 | |
|-------------------------------------|--|---|-------|------|-------|----|
| V _{BOOST} | Baset Output Veltage at VRUS | 2.5 V < V _{BAT} < 4.5 V; V _{BST} = 5 V; I _{LOAD} from 0 to 900 mA | 4.85 | 5.00 | 5.25 | V |
| | Boost Output Voltage at VBUS | $3.0 \text{ V} < \text{V}_{\text{BAT}} < 4.5 \text{ V}; \text{ V}_{\text{BST}} = 5 \text{ V};$ I _{LOAD} from 0 to 1500 mA | 4.75 | 5.00 | 5.25 | |
| I _{BAT(BOOST)} | Boost Mode Quiescent Current | V _{BAT} = 3.6 V; I _{LOAD} = 0 A | | 300 | 575 | μA |
| I _{LIMPK(BST)} (Note 9) | Q2 Peak Current Limit | | 3.3 | 4.1 | 5.7 | А |
| UVLO _{BST} | Minimum Battery Voltage for Boost | While Boost Active | | 2.32 | | V |
| | Operation | To Start Boost Regulator | | 2.48 | 2.70 | v |

PROTECTION AND TIMERS

| | V _{BUSOVP} VBUS Over-Voltage Threshold | V _{BUS} Rising; VBUSOVP (REG 15h[5:4]) = "00" | 6.35 | 6.50 | 6.65 | |
|--------------------------|---|---|-------|-------|-------|----|
| V _{BUSOVP} | | V _{BUS} Rising; VBUSOVP (REG 15h[5:4] = "01" | 10.25 | 10.50 | 10.75 | V |
| | | V _{BUS} Rising; VBUSOVP (REG 15h[5:4] = "10" | 13.4 | 13.7 | 14.0 | |
| V _{BUSOVP(HYS)} | V _{BUSOVP} Hysteresis | V _{BUS} Falling | | 100 | | mV |

Table 8. ELECTRICAL SPECIFICATIONS (continued)

Unless otherwise specified: V_{BUS} = 5.0 V; V_{BAT} = 3.7 V; HZMODE = "0"; BOOSTEN = "0" (Charge Mode); TREGTH = 120°C; I_{REG} = I_{LDO} = 0 A; SCL, SDA = 0 or 1.8 V; and typical values are for $T_A = 25^{\circ}C$

| Symbol Parameter | | Conditions | Min. | Тур. | Max. | Uni |
|-------------------------------------|---|--|------------------------------|------------------------------|------------------------------|-----|
| PROTECTION AN | ND TIMERS | | | | | |
| | | V _{IN} Rising; VINOVP (REG 17h[5:4]) = "00" | 6.35 | 6.50 | 6.65 | |
| VINOVP | V _{IN} Over-Voltage Threshold | V _{IN} Rising; VINOVP (REG 17h[5:4]) = "01" | 10.25 | 10.50 | 10.75 | V |
| | | V _{IN} Rising; VINOVP (REG 17h[5:4]) = "10" | 13.4 | 13.7 | 14.0 | |
| V _{BUSOVP(HYS)} | V _{INOVP} Hysteresis | V _{IN} Falling | | 100 | | m۷ |
| V _{BOOST} OVP | Boost Over-Voltage Threshold | BOOSTEN (REG 1Ch[5] = "1"; V _{BUS} Rising | 5.8 | 5.9 | 6.1 | V |
| - BOOSI_OVF | Hysteresis | V _{BUS} Falling | | 100 | | m∖ |
| | Battery Over-Voltage Threshold | Rising | 1.025* V _{FLOAT} | 1.050* V _{FLOAT} | 1.075* V _{FLOAT} | V |
| V _{BAT_OVP} | Hysteresis | V _{BAT} Falling relative to Rising Thresh- old | | 1 | | % |
| I _{LIMPK(CHG)} (Note 9) | High-Side Cycle-by-Cycle Peak Current Limit (Q1) | Charge Mode | 4.6 | 4.9 | 5.4 | А |
| I _{LIMQ4SC} | Q4 Short Circuit Current Limit | | 6.6 | 9.0 | | Α |
| tSCQUAL | Q4 Short Circuit Qualification Time | | | 1 | | ms |
| t _{SCRECOV} | Q4 Short Circuit Recovery Time | | | 2 | | se |
| t _{SHIPENTER} | Hardware Ship Mode Entry Time | Not in Ship Mode | | 8 | | se |
| t _{SHIPEXIT} | Hardware Ship Mode Exit Time | In Ship Mode | | 4 | | se |
| | Thermal Shutdown Threshold during Charging | T _J Rising | 150 | | | °C |
| (Note 9) | Hysteresis | T _J Falling | | T _{REGTH} | | 1 |
| T _{REGTH} (Note 9) | Thermal Regulation Threshold dur- ing Charging or Thermal Shutdown Threshold during Boost Operation | REG 0Fh[6:5]) = "10" | | 100 | | °C |
| t _{INT} | Battery Detection Interval while the Battery is Removed | | | 2.1 | | se |
| t _{FAST} | Safety Timer – Fast Range | | 240 | | 960 | miı |
| t _{PRE} | Safety Timer – Pre Range | | 1.667 | | 36.000 | miı |
| t _{TO} | Top Off Timer | | 10 | | 70 | mi |
| | | FAN54510A SDP Attached | | 100 | 120 | se |
| t _{USB} | USB Timer | FAN54512A SDP Attached | | 36 | 45 | miı |
| t _{SAFE_ACC} | Safety Timer Accuracy | | -20 | | 20 | % |
| | Welch Des Trees | Charger Enabled | 80 | 100 | 120 | se |
| t _{WD} | Watch Dog Timer | Charger Disabled | 73 | 100 | 127 | % |
| $\Delta t_{L F}$ (Note 13) | Low-Frequency Timer Accuracy | Charger Inactive | -27 | | 27 | % |

8. Limits over the recommended temperature operating range (-30 to 85 °C) are correlated by statistical quality control methods.

2. Limits over the recommended temperature operating range (-30 to 85 °C) are correlated by statistical quality control methods.
 9. Guaranteed by design and/or Characterization; not tested in production.
 10. Dropout voltage is determined by reducing the LDO input voltage until the LDO output voltage falls to 98% of its regulated voltage. Under this condition, PMID – VLDO (MEASURED) = VLDODROP.
 11. In LOW state, the pull-down is present. In HIGH state, the pull-down is released.
 12. Negative current is current flowing from the battery to GND (discharging the battery).

13. This tolerance (%) applies to all timers on the IC, including soft-start and deglitch timers.

Table 9. I²C TIMING SPECIFICATIONS

| Symbol | Parameter | Condition | Min. | Тур. | Max. | Unit |
|---------------------|--------------------------------|---|------|------|---|--|
| | | Standard Mode | | | 100 | |
| | | Fast Mode | | | 400 | |
| f _{SCL} | SCL Clock Frequency | Fast Mode Plus | | | 1000 | kHz |
| | | High–Speed Mode, $C_B \leq 100 \text{ pF}$ | | | 3400 | |
| | | High–Speed Mode, $C_B \le 400 \text{ pF}$ | | | 1700 | |
| | Bus-free Time between STOP and | Standard Mode | | 4.7 | | |
| t _{BUF} | START Conditions | Fast Mode | | 1.3 | | μs |
| | | Fast Mode Plus | | 0.5 | | |
| | | Standard Mode | | 4 | | μs |
| | START or Repeated START Hold | Fast Mode | | 600 | 400 1000 3400 1700 μ < | ns |
| ^t HD;STA | Time | Fast Mode Plus | | 260 | | 100 400 000 400 000 4400 700 700 μ |
| | | High-Speed Mode | | 160 | | ns |
| | | Standard Mode | | 4.7 | | μs |
| | | Fast Mode | | 1.3 | 100 400 1000 3400 1700 | μs |
| t _{LOW} | SCL LOW Period | Fast Mode Plus | | 0.5 | | |
| | | High–Speed Mode, C _B ≤ 100 pF 16 | 160 | | ns | |
| | | High–Speed Mode, $C_B \le 400 \text{ pF}$ | | 320 | | ns |
| | | Standard Mode | | 4 | | μs |
| | | Fast Mode | | 600 | | ns |
| t _{HIGH} | SCL HIGH Period | Fast Mode Plus | | 260 | ins ns μs ns ns ns | ns |
| | | High–Speed Mode, $C_B \le 100 \text{ pF}$ | | 60 | | ns |
| | | High–Speed Mode, $C_B \le 400 \text{ pF}$ | | 120 | | ns |
| | | Standard Mode | | 4.7 | | μs |
| | | Fast Mode | | 600 | | ns |
| ^t su;sta | Repeated START Setup Time | Fast Mode Plus | | 260 | μs μs ns ns ns μs ns μs ns μs ns ns | |
| | | High-Speed Mode | | 160 | | ns |
| | | Standard Mode | | 250 | | |
| | Data Setup Time | Fast Mode | | 100 | | |
| t _{SU;DAT} | | Fast Mode Plus | | 50 | | 115 |
| | | High-Speed Mode | | 10 | | |
| | | Standard Mode | 0 | | 3.45 | μs |
| | | Fast Mode | 0 | | 900 | ns |
| t _{HD;DAT} | Data Hold Time | Fast Mode Plus | 0 | | 450 | ns |
| | | High–Speed Mode, $C_B \leq 100 \text{ pF}$ | 0 | | 70 | ns |
| | | High–Speed Mode, C _B ≤ 400 pF | 0 | | 150 | ns |

| Table 9. I ² C TIMING SPECIFICATIONS (d | continued) |
|--|------------|
|--|------------|

| Symbol | Parameter | Condition | Min. | Тур. | Max. | Unit | |
|---------------------|--|--|----------------------|--------------------------|------|--|----|
| | | Standard Mode | 20+0.1C _B | | 1000 | | |
| | | Fast Mode | 20+0.1C _B | | 300 | | |
| t _{RCL} | SCL Rise Time | Fast Mode Plus | 20+0 | 0.1C _B | 120 | ns | |
| | | High–Speed Mode, $C_B \leq 100 \text{ pF}$ | | 10 | 80 | | |
| | | High–Speed Mode, $C_B \leq 400 \text{ pF}$ | | 20 | 160 | | |
| | | Standard Mode | 20+0 | 0.1C _B | 300 | | |
| | | Fast Mode | 20+0 | 0.1C _B | 300 | 0))))))))))))) | |
| t _{FCL} | SCL Fall Time | Fast Mode Plus | 20+0 | 0.1C _B | 120 | | |
| | | High–Speed Mode, $C_B \leq 100 \text{ pF}$ | | 10 | 40 | | |
| | | High–Speed Mode, $C_B \le 400 \text{ pF}$ | | 20 | 80 | | |
| | Rise Time of SCL after a Repeated | High–Speed Mode, $C_B \leq 100 \text{ pF}$ | | 10 | 80 | ns | |
| t _{RCL1} | START Condition and after ACK Bit | High–Speed Mode, $C_B \le 400 \text{ pF}$ | | 20 | 160 | | |
| | | Standard Mode | 20+0.1C _B | | 1000 | | |
| | | Fast Mode 20+0.1C _B 300 | | | | | |
| t _{RDA} | SDA Rise Time | Fast Mode Plus | 20+0 | 20+0.1C _B 120 | | ns | |
| | | High–Speed Mode, $C_B \le 100 \text{ pF}$ | | 10 | 80 | | |
| | | High–Speed Mode, $C_B \le 400 \text{ pF}$ | | 20 | 160 | | |
| | | Standard Mode | 20+0.1C _B | | 300 | | |
| | | Fast Mode | 20+0 | 0.1C _B | 300 | ns ns ns ns ns us ns us ns ns | ns |
| t _{FDA} | SDA Fall Time | Fast Mode Plus | 20+0 | 0.1C _B | 120 | | |
| | | High–Speed Mode, $C_B \le 100 \text{ pF}$ | | 10 | 80 | | |
| | | High–Speed Mode, $C_B \le 400 \text{ pF}$ | | 20 | 160 | | |
| | | Standard Mode | | 4 | | μs | |
| | | Fast Mode | | 600 | | ns | |
| t _{SU;STO} | Stop Condition Setup Time Fast Mode Plus | 1 | 120 | | ns | | |
| | | High-Speed Mode | | 160 | | ns | |
| CB | Capacitive Load for SDA and SCL | | | | 400 | pF | |

CIRCUIT OVERVIEW

The FAN5451x combines a highly integrated synchronous buck regulator for battery charging and providing system power. The converter can also operate as a boost regulator, which can supply 5 V to USB On–The–Go (OTG) peripherals. The regulator employs synchronous rectification for both the charger and boost operations to maintain high efficiency over a wide range of adapter input voltage and battery voltages.

With dual inputs, the charger can quickly switch between multiple power sources. For example, the charger can be powered from a wireless power receiver until plugged into a traditional USB or wall adapter.

An integrated Power Path FET facilitates fast system startup. This FET also accurately senses charging current, thus eliminating the need for an external sense resistor. Additionally, the FET provides a low impedance path from the battery to the system.

OPERATING MODES

The FAN5451x has seven operating modes:

Linear Mode:

When $V_{BAT} < V_{SHORT}$ (2.0 V), the buck converter regulates voltage at SYS and provides the system current enabling instant turn on of the system. The BATFET (Q4) charges the battery at the I_{SHORT} current to safely recover the battery.

Pre-Charge Mode:

Above V_{SHORT} , the buck converter regulates voltage at SYS and provides the system current. The BATFET (Q4) is operated as a linear current source to pre-charge the battery under I_{PP} control.

Fast Charge Mode:

The BATFET (Q4) is fully enhanced, charging the battery under I_{OCHRG} control either in the Constant Current Mode or Constant Voltage Mode from the output of the buck regulator.

System Mode (Idle State):

The buck converter regulates voltage at SYS and provides the system current, while the battery is not being charged. This mode can occur if the battery charging has terminated or charging is disabled.

Supplemental Mode

The buck converter cannot produce enough current to maintain V_{SYS} above V_{BAT} . The BATFET (Q4) is fully enhanced to provide supplemental current from the battery to the system load.

Boost Mode

Q1 and Q2 operate as a synchronous boost regulator to provide power to the VBUS pin for USB-On-the-Go (OTG) applications using the battery as its input. The boost converter output voltage is programmable.

High-Impedance Mode (Standby State)

Both the boost and charging circuits are OFF and the battery is providing current to the system. Current flow from VBUS or VIN to the battery or from the battery to VBUS or VIN is blocked.

CONFIGURABLE CHARGE PARAMETERS

The following charging parameters can be programmed by the host through I^2C :

Pre-Charge Current Regulation (IPP)

Limits the maximum battery charging current when $V_{SHORT} < V_{BAT} < V_{BATMIN}$. The default setting is 450 mA. See *PRECHG* (REG 13h[3:0])

Minimum Battery Threshold (V_{BATMIN})

Sets the battery voltage threshold for transitioning between Pre–Charge and Fast Charge. V_{BATMIN} should not be set lower than the minimum required system voltage. The default setting is 3.4 V.

See VBATMIN (REG 0Ch[2:0])

Regulated System Voltage (V_{SYS})

Regulates the system voltage when $V_{BAT} < V_{BATMIN}$. VSYS should be programmed 200 mV, or more, above the minimum required system voltage. The default setting is 3.6 V.

See VSYS (REG 0Dh[1:0])

Fast Charge Current Regulation (IOCHRG)

Limits the maximum battery charging current when $\ensuremath{V_{BAT}}$

> V_{BATMIN}. The default setting is 1000 mA. See *IOCHRG* (REG 12h[5:0])

Thermal Regulation (T_{REG})

Limits charge current to prevent the IC from overheating. The default setting is 100°C. See *TREGTH* (REG 0Fh[6:5])

Output Voltage Regulation (V_{FLOAT})

Maximum battery charging voltage. The default setting is 4.35 V.

See FLOAT (REG 11h[7:0])

Charge Termination Threshold (I_{TERM})

Terminates charging at the desired current when TE (termination enable)="1". The default setting is 300 mA. See *ITERM* (REG 13h[7:4])

CONFIGURABLE INPUT POWER PARAMETERS

The following input power parameters can be programmed by the host through I^2C :

VBUS Input Current Limit (IBUSLIM)

Limits the amount of current drawn from the VBUS source. The default setting is 500 mA.

See IBUSLIM (REG 14h[6:0])

VIN Input Current Limit (IINLIM)

Limits the amount of current drawn from the VIN source. The default setting is 1 A.

See IINLIM (REG 16h[6:0])

Dynamic Input Voltage Control (V_{SOURCE})

Limits the input current when a current–limited weak adapter is connected to either of VBUS or VIN. The settings are configurable from 4.2 V to 8.6 V. The default settings are 4.56 V.

See VBUSLIM (REG 15h[3:0]) and VINLIM (REG 17h[3:0])

CONFIGURABLE BOOST PARAMETERS

The following boost parameters can be programmed by the host through I²C:

Boost Output Voltage (V_{BOOST})

Regulates the boost converter output voltage on PMID when BOOSTEN = "1". When OTG = "1" VBUS is connected to PMID. The default setting is 5.0 V.

See VBOOST (REG 1Ch[3:0]).

CHARGE MODE TYPICAL CHARACTERISTICS

Unless otherwise specified, circuit of Typical Application, using FAN54511A, default register values/settings, V_{BUS} = 5.0 V, and T_A = 25°C.

4,000



Figure 9. Efficiency vs. IOCHRG, V_{BAT} = 4.3 V, I_{BUSLIM} = 3.0 A, I_{INLIM} = 2.0 A



Figure 10. Efficiency vs. IOCHRG, V_{BAT} = 3.8 V, I_{BUSLIM} = 3.0 A, I_{INLIM} = 2.0 A





Figure 11. Fast Charge Current vs. V_{BAT}, I_{OCHRG} = 3.2 A, I_{BUSLIM} = I_{INLIM} = 500 mA, V_{FLOAT} = 4.5 V

Figure 12. Fast Charge Current vs. V_{BAT}, I_{OCHRG} = 3.2 A, I_{BUSLIM} = I_{INLIM} = 1,500 mA, V_{FLOAT} = 4.5 V

CHARGE MODE TYPICAL CHARACTERISTICS

(Unless otherwise specified, circuit of Typical Application, using FAN54511A, default register values/settings, V_{BUS} = 5.0 V, T_A = 25°C



Battery Voltage, V_{BAT} (V)

Figure 13. Peak Available Load Current (I_{BAT} + I_{SYS}) vs. V_{BAT} , I_{BUSLIM} = 3.0 A, I_{INLIM} = 2.0 A, V_{FLOAT} = 4.5 V







Figure 17. Startup at V_{BUS} Plug–In, V_{BAT} = 3.2 V, 50 Ω SYS Load, ILIM = "0"



Figure 14. Quiescent Current vs. Input Voltage, $I_{SYS} = 0 A$, No Battery, LDO Off, NTC = GND,



Battery Voltage, VBAT (V)

Figure 16. Battery Discharge Current vs. V_{BAT}, Ship Mode



Figure 18. Startup at V_{BUS} Plug–In, V_{BAT} = 3.8 V, 50 Ω SYS Load, ILIM = "0"

CHARGE MODE TYPICAL CHARACTERISTICS (continued)

(Unless otherwise specified, circuit of Typical Application, using FAN54511A, default register values/settings, V_{BUS} = 5.0 V, and T_A = 25°C)



Figure 19. Startup at V_{BUS} Plug–In, Dead Battery, 50 Ω SYS Load, ILIM = "0"



Figure 21. Startup at V_{BUS} Plug–In, No Battery, 50 Ω SYS Load, ILIM = "0"



Figure 23. V_{BUS} Un–Plug, 3.8 V_{BAT}, 50 Ω SYS Load, ILIM = "0"



Figure 20. FAN54510 Startup at V_{BUS} Plug–In, V_{BAT} = 3.2 V, 50 Ω SYS Load, SDP, No Host Control



Figure 22. V_{BUS} Plug-In with V_{SOURCE} Validation Fail, V_{BAT} = 3.8 V, 50 Ω SYS Load



Figure 24. Charge Termination, TE = TOEN = "1", I_{TERM} = 300 mA, 100 mA SYS Load

CHARGE MODE TYPICAL CHARACTERISTICS (continued)

(Unless otherwise specified, circuit of Typical Application, using FAN54511A, default register values/settings, V_{BUS} = 5.0 V, and T_A = 25°C)



Figure 25. Battery Removal/Insertion while Charging, TE = "0", V_{BAT} = 3.8 V, 50 mA SYS Load, I_{BUSLIM} = 1.5 A, I_{OCHRG} = 2.0 A



Figure 27. V_{BUS} OVP Response While Charging, V_{BAT} = 3.8 V, 50 Ω SYS Load, ILIM = "0"



Figure 29. Load Pulse Response, 150 mA-2150 mA- 150 mA SYS Load with $t_R = t_F = 10 \ \mu sec$, 4.35 V_{BAT}, I_{BUSLIM} = 1.5 A, I_{ORCHG} = 3.0 A, TE = "0"



Figure 26. V_{BUS} Plug–In OVP Condition, V_{BAT} = 3.8 V, 50 Ω SYS Load, ILIM = "0"



Figure 28. Load Pulse Response, 150 mA-2150 mA- 150 mA SYS Load with $t_R = t_F = 10 \ \mu sec$, 3.8 V_{BAT}, I_{BUSLIM} = 1.5 A, I_{OCHRG} = 3.0 A



Figure 30. Input Source Selection, 5.0 V_IN Present, Insert/Remove 5.0 V_BUS, 3.8 V_BAT, 50 Ω SYS Load

CHARGE MODE TYPICAL CHARACTERISTICS (continued)

(Unless otherwise specified, circuit of Typical Application, using FAN54511A, default register values/settings, V_{BUS} = 5.0 V, and T_A = 25°C)



Figure 31. Battery Discharge Current Limit Response to SYS Fault, Sleep Mode, 3.8 $\ensuremath{\mathsf{V}_{\mathsf{BAT}}}$

CHARGE MODE TYPICAL CHARACTERISTICS

(Unless otherwise specified, using circuit of Typical Application, V_{BAT} = 3.8 V, V_{BOOST} = 5.00 V, T_A = 25°C. Boost enabled by writing BOOSTEN = OTG = "1", simultaneously.)



Figure 32. Efficiency vs. Load Current



Figure 33. Efficiency vs. Load Current, 3.7 V_{BAT}



Figure 34. Output Regulation



Figure 35. Output Ripple vs. Load Current



Figure 36. Quiescent Current

Figure 37. Load Current Limit, 5.00 VBOOST

CHARGE MODE TYPICAL CHARACTERISTICS

(Unless otherwise specified, using circuit of Typical Application, V_{BAT} = 3.8 V, V_{BOOST} = 5.00 V, T_A = 25°C. Boost enabled by writing BOOSTEN = OTG = "1", simultaneously.)



Figure 38. Load Current Limit vs. VBOOST



Figure 39. Boost Startup, 50 Ω Load







Figure 40. Boost Startup, 5 $\Omega \parallel$ 10 μF Load



Figure 42. Line Transient Response, 500mA Load, 3.8 V_{BAT} –3.2 V_{BAT} –3.8 V_{BAT} with t_R = t_F = 10 μsec

CHARGE MODE TYPICAL CHARACTERISTICS

(Unless otherwise specified, using circuit of Typical Application, $V_{BAT} = 3.8 \text{ V}$, $V_{BOOST} = 5.00 \text{ V}$, $T_A = 25^{\circ}\text{C}$. Boost enabled by writing BOOSTEN = OTG = "1", simultaneously.)



Figure 43. V_{BUS} Output Fault Response



Idle State

During Idle State the PWM Buck continues to regulate system voltage to V_{FLOAT} providing power to the system. The battery is not being charged and the BATFET (Q4) is off.

In the Idle State, the V_{BAT}/V_{SYS} comparator is monitored and if V_{SYS} falls below V_{BAT} by V_{THSYS} , the BATFET (Q4) is fully enhanced for Supplemental Mode operation.

If Idle State is entered for any of the following conditions, a return to Charge State occurs when the related condition is removed:

- 1. Charge Complete (CHGCMP = "1") occurs with TE = "1". If RCHGDIS (REG 0Eh[5]) = "0", the IC will return to Charge State when $V_{BAT} < V_{FLOAT} - V_{RCHG}$.
- 2. The Top–Off Timer (t_{TO}) expires. If RCHGDIS (REG 0Eh[5]) = "0", the IC will return to Charge State when $V_{BAT} < V_{FLOAT} - V_{RCHG}$.
- 3. The battery is below T1 or above T4. See JEITA Charging section for details.
- 4. The battery is removed and TE = "1".
- 5. The BATFET is disabled by the Charge Enable bit, CE# = "1".

If Idle State is entered for any of the following conditions, the only way to restart charging is to first remove V_{SOURCE} , and then reconnect a valid VIN or VBUS power source:

- The Safety Timer (t_{PRE} or t_{FAST}) expires when CONT (REG 0Eh[7]) = "0".
- 2. The battery voltage drops below V_{SHORT} during charging.
- 3. The Watch Dog Timer (t_{WD}) expires and WDTEXP (REG 30h[7]) = "1".



Figure 44. Boost Startup into V_{BUS} Fault

Standby State

The Standby State is an intermediate state where the PWM Buck is off and the BATFET (Q4) is fully enhanced. During Standby State, reverse current out of the VBUS or VIN pin is prevented by turning off the Q3 and Q5 blocking FETs.

If Standby State is entered for any of the following conditions, a return to Charge State occurs when the related condition is removed:

- 1. Sleep State where V_{SOURCE} < V_{BAT} + V_{SLP} or V_{SOURCE} < V_{SOURCE}(FALL).
- 2. The device has been put in Hi–Z state by HZMODE (REG 0Eh[1]) = "1" or DIS = HIGH.
- 3. The die temperature is in thermal shutdown (T_{SHUTDOWN}).

If Standby State is entered for any of the following conditions, the only way to restart charging is to first remove V_{SOURCE} , and then reconnect a valid VIN or VBUS power source:

1. The USB Timer (t_{USB}) expires (FAN54510A and FAN54512A only).

Sleep State

Sleep State is part of the suite of conditions which make up the Standby State. The BATFET (Q4) is fully enhanced while the IC is in the Sleep State. This ensures that the FAN5451x powers the system from the battery when operating without a valid input source on either VBUS or VIN.

APPLICABLE STATUS AND INTERRUPT

Status Bits: SLEEP (REG 00h[1])

CHARGER CIRCUIT DETAILS

Refer to:

Charger State Diagram" State and Mode Transitions and

Charger State Diagram: Charger/Battery/System Protection

Plug In: Source Selection and Validation

Source Selection

Only one input source (VBUS or VIN) can be routed to the buck converter at any given time. If valid power sources are connected to both VIN and VBUS, the input selector automatically opens Q5 and closes Q3, thereby selecting VBUS as the input source to the buck converter.

The active source is identified by a Status bit.

APPLICABLE STATUS AND INTERRUPT

Status Bits: INPUTSEL (REG 02h[7])

Battery Capacitor Discharge

When either V_{BUS} or V_{IN} rises and remains above $V_{SOURCE(RISE)}$ for the $t_{SRCQUAL}$ (32 mS) duration, the IC applies a I_{DETECT} (-8 mA) load to V_{BAT} for T_{DETECT} (262 ms) to ensure that if the battery is not present, or its discharge protection switch is open, the capacitors on V_{BAT} will be discharged below the V_{SHORT} threshold.

D+/D- Adapter Detection (VBUS only)

See Table 11 and Table 12 for the FAN5451x versions that have this feature.

When V_{BUS} rises and remains above $V_{SOURCE(RISE)}$ for the $t_{SRCQUAL}$ (32 mS) duration, the FAN5451x versions that have this feature perform adapter detection.

SDP, CDP, and DCP adapter types can be uniquely identified by the Charger IC, which will automatically select the appropriate I_{BUS} current limit per the USB Battery Charging Specification (BC1.2), and report the adapter type in a Status register.

APPLICABLE STATUS AND INTERRUPT

Status Bits: CHGDET (REG 01h[6:5])

Source Voltage Validation

After battery capacitor discharge, Source Voltage Validation occurs with a $I_{VSOURCE}$ (50 mA) load on PMID. To pass validation, either V_{BUS} or V_{IN} must remain above $V_{SOURCE(RISE)}$ and below $V_{SOURCEOVP}$ for t_{VSR} _VALID (32 ms) before the IC initiates charging. T_{VSR} _VALID ensures that unfiltered 50/60 Hz chargers and other non-compliant chargers are rejected.

APPLICABLE STATUS AND INTERRUPT

| Pins: | /BUSOK /INOK /INT |
|-----------------|--|
| Interrupt Bits: | VBUSINT (REG 04h[5]) VININT (REG 04h[6]) |
| Status Bits: | VBUSPWR (REG 00h[5]) VINPWR (REG 00h[6]) INPUTSEL (REG 02h[7]) |

If the input source fails validation, the validation period is extended an additional 32 ms and source validation is re-tried. A failure will result in an interrupt and the part returning to Sleep State, where the entire validation routine will restart when $V_{SOURCE} > V_{SOURCE(RISE)}$.

APPLICABLE STATUS AND INTERRUPT

| Pins: | /INT |
|-----------------|----------------------|
| Interrupt Bits: | VALFAIL (REG 04h[7]) |

Battery Voltage Measurement

The battery voltage is measured if the adapter passes Source Validation. The IC can identify an absent, shorted, low, or dead battery, configure the charging parameters accordingly, and then enter Charge Mode.

Figure 45, Figure 46, and Figure 47 illustrate Plug In timing under various conditions. The t_{DELAY} timing specification is affected by V_{BAT} and is described in Table 10.

Table 10. T_{DELAY} TIMING vs. V_{BAT}

| V _{BAT} (V) | T _{DELAY} (ms) |
|--|-------------------------|
| < V _{BATMIN} | 69 |
| V _{BATMIN} < V _{BAT} < V _{LOWV} | 37 |
| > V _{LOWV} | 10 |





Figure 45. VBUS or VIN Plug In, V_{BAT} < V_{SHORT}

Figure 46. VBUS Plug In, SDP, $V_{BAT} < V_{SHORT}$



Figure 47. VBUS Plug In, CDP, V_{BAT} < V_{SHORT}

CHARGE MODES

Auto-Charge and Establishing Host Control

The FAN5451x features Auto-Charge, which supports battery charging prior to Host Control.

After the source voltage has been validated at Plug In, if $V_{BAT} < V_{BATMIN}$, the IC resets all registers to their default values. Regardless of battery voltage, the IC then operates in accordance with its I²C register settings except that the IBUSLIM (REG 14h[6:0]) settings are ignored until the first I²C write after charging begins.

Only after the first I²C write after charging begins is Host Control established.

Prior to Host Control, the I_{BUS} current limit and the charge timer length are as described in Table 11 and Table 12.

Once Host Control has been established, the charge parameter settings are as described in Table 13.

For FAN5451x versions where the BC1.2 adapter detection circuit is enabled, the I_{BUS} current limit prior to establishing Host Control is determined by D+/D- Adapter Detection at Plug In. If the adapter type cannot be identified as either CDP or DCP, the charger will be configured to SDP Auto-Charge.

SDP Auto–Charge uses a dedicated SDP timer (t_{USB}) with the I_{BUS} current limit configured as per Table 11. If the t_{USB} timer is allowed to expire, the charger enters Standby State, where the only way to restart charging is to first remove $V_{\mbox{SOURCE}}$ then reconnect a valid VIN or VBUS power source.

If a SDP adapter is detected and $V_{BAT} > V_{LOWV}$, the charger will disable the LDO and enter Standby State, where any I²C write to the IC will return it to Charge Mode under Host Control.

If a SDP adapter is detected and the DIS pin is HIGH, the LDO will be disabled after validation and remain disabled until SDP charging occurs when DIS is driven LOW or Host Control is established.

If a CDP or DCP adapter is detected, Auto–Charge uses the Safety Timer with the I_{BUS} current limit set to 1500 mA.

ILIM Pin Control Auto-Charge Mode

See Table 11 and Table 12 for the FAN5451x versions that have this feature.

For FAN5451x versions where the BC1.2 adapter detection circuit is disabled, the ILIM pin is used to set the I_{BUS} current limit prior to Host Control.

ILIM Pin Auto-Charge uses the Safety Timer with the I_{BUS} current limit configured as per Table 11.

| Part Number | Configuration | BC1.2 SDP | BC1.2 CDP/DCP | ILIM Pin Control (ILIM Pin = HIGH) | ILIM Pin Control (ILIM Pin = LOW) |
|-------------|------------------|-----------|---------------|---------------------------------------|--------------------------------------|
| FAN54510A | BC1.2 Detection | 500 mA | 1500 mA | N/A | N/A |
| FAN54511A | ILIM Pin Control | N/A | N/A | 500 mA | 1500 mA |
| FAN54511AP | ILIM Pin Control | N/A | N/A | 500 mA | 1500 mA |
| FAN54512A | BC1.2 Detection | 100 mA | 1500 mA | N/A | N/A |
| FAN54513A | ILIM Pin Control | N/A | N/A | 100 mA | 1500 mA |

Table 11. I_{BUS} CURRENT LIMIT (AUTO-CHARGE ONLY)

Table 12. CHARGE TIMER (AUTO-CHARGE ONLY)

| Part Number | Configuration | BC1.2 SDP | BC1.2 CDP/DCP | ILIM Pin Control |
|-------------|------------------|----------------------------|---------------|------------------|
| FAN54510A | BC1.2 Detection | t _{USB} = 2 min. | Safety Timer | N/A |
| FAN54511A | ILIM Pin Control | N/A | N/A | Safety Timer |
| FAN54511AP | ILIM Pin Control | N/A | N/A | Safety Timer |
| FAN54512A | BC1.2 Detection | t _{USB} = 45 min. | Safety Timer | N/A |
| FAN54513A | ILIM Pin Control | N/A | N/A | Safety Timer |

| | | | Charger Bit Settings | | | | | |
|----------------|---------|-----------------------|----------------------|---------|--------|---------|------|-------|
| Operating Mode | VSOURCE | VBAT | IINLIM | IBUSLIM | PRECHG | IOCHRG | STAT | PWROK |
| Linear | Valid | < V _{SHORT} | 1000 mA | 500 mA | 50 mA | Х | 1 | 0 |
| Pre-Charge | Valid | < V _{BATMIN} | 1000 mA | 500 mA | 450 mA | Х | 1 | 0 |
| FAST Charge | Valid | > V _{BATMIN} | 1000 mA | 500 mA | Х | 1000 mA | 1 | 0 |
| FAST Charge | Valid | > V _{LOWV} | 1000 mA | 500 mA | Х | 1000 mA | 1 | 1 |
| Top-Off | Valid | > V _{LOWV} | 1000 mA | 500 mA | Х | 1000 mA | 0 | 1 |
| Recharge | Valid | > V _{LOWV} | 1000 mA | 500 mA | Х | 1000 mA | 1 | 1 |

Table 13. CHARGE PARAMETER SETTING VS. OPERATING MODE (HOST CONTROL ONLY)

Linear Pre-Charge Mode

At the beginning of charging, if $V_{BAT} < V_{SHORT}$, the BATFET (Q4) operates as a linear current source with its current limited to 50 mA (I_{SHORT}) in order to safely recover a battery pack with an open protection switch. Additionally, the IC delivers power to SYS by regulating V_{SYS} to the default VSYS (REG 0Dh[1:0]) setting.

Pre-Charge (IPP) Mode

At the beginning of charging, if $V_{SHORT} < V_{BAT} < V_{BAT}$, or if V_{BAT} has transitioned above V_{SHORT} from Linear Pre-Charge Mode, the IC enters Pre-Charge Mode while delivering power to SYS.

During Pre-Charge Mode, the BATFET (Q4) will operate as a linear current source with its current limited to the PRECHG (REG 13h[3:0]) setting. The IC will regulate V_{SYS} to the VSYS (REG 0Dh[1:0]) setting and attempt to charge the battery at less than or equal to the PRECHG setting without allowing V_{SYS} to drop below V_{BATMIN} .

All registers are programmable in Pre-Charge Mode.

APPLICABLE STATUS AND INTERRUPT

| Pins: | /STAT /INT |
|-----------------|---------------------------------------|
| Interrupt Bits: | WKBAT (REG 04h[1]) |
| Status Bits: | PRE (REG 00h[2]) STAT (REG 00h[3]) |

Fats Charge (I_{OCHRG}) Mode

At the beginning of charging, if $V_{BAT} > V_{BATMIN}$, or if V_{BAT} has transitioned above V_{BATMIN} from Pre-Charge Mode, the IC enters Fast Charge.

During Fast Charge Mode, the BATFET (Q4) is fully enhanced and acts as a current sense element to limit charge current per the IOCHRG (REG 12h[5:0]) setting. Battery charging under constant current (CC) I_{OCHG} control continues until the battery voltage reaches V_{FLOAT} . APPLICABLE STATUS AND INTERRUPT

| Pins: | /INT /STAT | |
|-----------------|---------------------|--|
| Interrupt Bits: | CHGMOD (REG 04h[2]) | |

Good Battery Threshold (VLOWV)

The VLOWV (REG 0Ch[5:3]) bits define a battery voltage threshold between 3.0 V and 3.7 V where an interrupt is generated. The system designer can use this interrupt to indicate that full system power is available or for any other purpose. Charge parameters are not affected by VLOWV.

APPLICABLE STATUS AND INTERRUPTS

| Pins: | /INT |
|-----------------|----------------------|
| Interrupt Bits: | VLOWVTH (REG 04h[4]) |
| Status Bits: | PWROK (REG 00h[4]) |

Constant Voltage (CV) Mode

When V_{BAT} reaches V_{FLOAT} , as set by VFLOAT (REG 11h [7:0]), the charger enters the voltage regulation (CV Mode) phase of charging. The PWM regulator goes from regulating current across the BATFET (Q4) to regulating voltage on the BATSNS pin. This results in charge current declining.

The CV (REG 20h[0]) Monitor bit will be set to a "1" while the IC is in CV Mode.

Termination

Charge current termination is enabled when TE (REG 0Eh[3]) = "1". When charge current falls below I_{TERM} , as set by ITERM (REG 13h[7:6]), for longer than the deglitch time of 30 ms, charging stops, Q4 turns off, an interrupt is issued, and the IC enters Idle State (Charge Complete) if TOEN (REG 0Eh[2]) = "0". The buck converter will regulate SYS to VFLOAT (REG 11h[7:0]) and the battery will support Supplemental Mode if required.

Recharge occurs after Termination (TE = "1"), if RCHGDIS (REG 0Eh[5]) = "0", when $V_{BAT} < V_{FLOAT} - V_{RCHG}$.

Charge termination is blocked unless the I_{TERM} threshold is crossed while in CV Mode. If another control loop (IBUSLIM, IOCHRG, DIVC) or Supplemental Mode operation exist, termination will be prevented until the CV condition is met.

APPLICABLE STATUS AND INTERRUPT

| Pins: | /INT /STAT |
|-----------------|---------------------|
| Interrupt Bits: | CHGEND (REG 04h[3]) |
| Status Bits: | CHGCMP (REG 01h[4]) |

If TE = "0", when the charge current falls below I_{TERM} , charging continues, an interrupt is issued, but the CHGCMP bit is not set.

APPLICABLE STATUS, INTERRUPT AND MONITOR

| Pins: | /INT |
|-----------------|-----------------------|
| Interrupt Bits: | IBATLO (REG 05h[7]) |
| Status Bits: | LOIBAT (REG 01h[7]) |
| Monitor Bits: | ITERMCMP (REG 20h[7]) |

Top-Off Charging Mode

Top-Off Charging occurs after Termination (TE = "1") if TOEN (REG 0Eh[2]) = "1". The CHGEND interrupt will be issued and Top-Off Charging begins 400 ms later with the /STAT pin HIGH. During Top-Off Charging, the Battery Absence Detection is retried every 5s unless TO_BDETDIS (REG 1Bh[3]) is set to "1".

The Top–Off Charging duration is set by the Top–Off Timer, TOTMR (REG 1Bh[2:0]). See Top–Off Timer for details.

APPLICABLE STATUS AND INTERRUPT

| Pins: | /INT STAT |
|-----------------|--|
| Interrupt Bits: | CHGEND (REG 04h[3]) TOCMP (REG 06h[7]) |
| Status Bits: | STAT (REG 00h[3]) LOIBAT (REG 01h[7]) TOCHG (REG 01h[3]) |

System Current Prioritization

During Charge Mode, if the current available to charge is less than the programmed charge setting due to an input current limit setting, source limitations, or system load requirements, the current to the battery will be reduced to support the system load.

Supplemental Mode

During Charge Mode or Idle State, if the system load exceeds what the buck converter can provide, V_{SYS} will drop. If a falling V_{SYS} drops more than V_{THSYS} below V_{BAT} , the BATFET (Q4) will be fully enhanced to hold the system up to V_{BAT} .

Then, once a rising V_{SYS} becomes higher than V_{BAT} by V_{THSYS} , the BATFET (Q4) again serves as the current sense element to limit the charge current.

| PWM | Operating Mode | CE# | V _{SOURCE} | V _{BAT} | BATFET (Q4) |
|-----|--|-----|----------------------|----------------------|-------------|
| OFF | SLEEP | х | Both < (VSYS + VSLP) | Х | ON |
| ON | Linear and Pre-Charge | 0 | Valid | > VSHORT & < VBATMIN | Linear |
| ON | FAST Charge | 0 | Valid | > VBATMIN & < VSYS | ON |
| OFF | HZMODE (REG 0Eh[1]) = "1" | Х | Х | Х | ON |
| ON | Supplemental | Х | Valid | > VSYS | ON |
| ON | CE# = "1" (disable Q4 with Supplemental Mode remaining functional) | 1 | Valid | < VSYS | OFF |
| ON | PPOFF = "1" (disable Q4 with Supplemental Mode disabled) | х | Valid | х | OFF |

Table 14. SUMMARY OF BATFET (Q4) OPERATION VS. OPERATING MODE

Source Plug Out

The IC continuously monitors V_{BUS} (or V_{IN}) during charging. If V_{SOURCE} falls below the higher of $V_{SOURCE(FALL)}$ or $V_{BAT}+V_{SLP}$ the IC terminates charging and enters Sleep State (Standby).

APPLICABLE STATUS AND INTERRUPT

| Pins: | /BUSOK /INOK /INT /STAT |
|-----------------|--|
| Interrupt Bits: | VLOWTH (REG 04h[4]) VBUSINT (REG 04h[5]) VININT (REG 04h[6]) |
| Status Bits: | SLEEP (REG 00h[1]) VBUSPWR (REG 00h[5]) VINPWR (REG 00h[6]) INPUTSEL (REG 02h[7]) |

CHARGING STATUS AND INTERRUPT REPORTING

Charging Status

The /STAT pin is used to report the charge status to the host processor. During charge, the /STAT pin is LOW. After Termination, the /STAT pin goes HIGH and will remain HIGH even during Top–Off Charging Mode.

The STAT (REG 00h[3]) bit indicates a "1" when charging except during Top–Off.

APPLICABLE STATUS AND INTERRUPT

| Pins: | /STAT |
|--------------|-------------------|
| Status Bits: | STAT (REG 00h[3]) |

Interrupts

The /INT pin is used to indicate that one or more unmasked interrupt bits have been set.

The pin will remain LOW until all set interrupt bits (Registers 04h to 06h) are read and cleared. In the event that another interrupt occurs while the register containing the bit is read, the interrupt will be stored in a buffer and transferred to the register after the read. Thus, the /INT pin may remain LOW until the register is read and cleared again.

APPLICABLE STATUS AND INTERRUPT

| Pins: | /INT |
|-----------------|---|
| Interrupt Bits: | INT 0 (REG 04h) INT 1 (REG 05h) INT 2 (REG 06h) |

Interrupt Masking

Masking an interrupt bit using its corresponding mask bit, found in registers 08h to 0Ah, prevents a masked interrupt event from setting the /INT pin to LOW. The associated interrupt bit will be set to "1".

CHARGER/BATTERY/SYSTEM PROTECTIONS

Dynamic Input Voltage Control

The IC includes a Dynamic Input Voltage Control (DIVC) loop which automatically limits input current in case a current–limited source is supplying V_{BUS} or V_{IN} . The control loop increases the charging current until either: I_{BUSLIM} / I_{INLIM} or I_{OCHRG}

is reached or

 $V_{BUS} = V_{BUSLIM}$ or $V_{IN} = V_{INLIM}$

If an increase in load occurs on VSYS during charging that causes VBUS or VIN to reduce below VBUSLIM or VINLIM, the charge current is reduced until VBUS or VIN rise to the VBUSLIM or VINLIM threshold. At V_{SOURCE} plug in, the VBUSLIM (REG 15h[3:0]) and VINLIM (REG 17h[3:0]) bits are always set to their default values.

High-Impedance Mode and Disable

Setting the HZMODE (REG 0Eh[1]) bit to "1" or setting the DIS pin to HIGH disables the charger and puts the IC into High–Impedance Mode (HZ). The Safety Timer and Watch Dog Timer are reset.

If V_{BAT} falls below V_{BATMIN} , with HZMODE set to "1", the HZMODE bit will automatically reset to "0", and charging will commence. Setting HZMODE = "1" when $V_{BAT} < V_{BATMIN}$ is ignored. The DIS pin is functional when $V_{BAT} < V_{BATMIN}$.

Safety Timer

At the beginning of charging, the IC starts the Safety Timer. The Safety Timer consists of two segments, Pre-Charge (PRETMR) and Fast Charge (FCTMR). The Safety Timer can be programmed using the bits in the TIMER (REG 19h) register.

The Pre-Charge timer begins at the start of charging of a battery whose voltage is less than V_{BATMIN} . Once the battery voltage has risen above V_{BATMIN} , the Pre-Charge Timer is cleared and the Fast Charge Timer begins. If the battery voltage were to fall below V_{BATMIN} during Fast Charge, the Fast Charge Timer will continue to run until the battery is fully charged or the timer expires.

Charging with the Safety Timer running is used for charging that is unattended by the host. If the Safety Timer expires charging ceases, all registers reset to their default values, the device enters Idle State, and an interrupt is issued.

If the CONT (REG 0Eh[7]) = "1", charging will continue if the Safety Timer is allowed to expire.

APPLICABLE STATUS AND INTERRUPT

| Pins: | /INT /STAT |
|-----------------|-------------------------------|
| Interrupt Bits: | TIMER (REG 06h[0]) |
| Status Bits: | TMRTO Status bit (REG 02h[0]) |

Watch Dog Timer (WDT)

Setting WDEN (REG 19h[6]) to "1" enables the WDT and disables, but does not clear the Safety Timer.

Setting TMRRST (REG19h[7]) to "1" resets the WDT. This bit should be written at a rate more frequent than t_{WD} .

If the WDT expires, charging continues on the remainder of the time left on the Safety Timer. Additionally, all registers except SAFETY (REG 1Ah[7:0]), are reset to their default values, and an interrupt is issued. If WDTEXP (REG 30h[7]) = "1" and the WDT expires, the device will instead immediately enter Idle State.

APPLICABLE STATUS AND INTERRUPT

| Pins: | /INT /STAT |
|-----------------|--------------------|
| Interrupt Bits: | TIMER (REG 06h[0]) |
| Status Bits: | WDTTO (REG 02h[1]) |

Top-Off Timer

The Top–Off timer duration is programmable using the TOTMR (REG 1Bh [2:0]) bits. When the timer expires charging stops, the BATFET (Q4) is disabled, an interrupt is issued, and the device enters Idle State. If RCHGDIS (REG 0Eh[5]) = "0", the IC will return to Charge State when $V_{BAT} < V_{FLOAT} - V_{RCHG}$.

APPLICABLE STATUS AND INTERRUPT

| Pins: | /INT |
|-----------------|---------------------|
| Interrupt Bits: | TOCMP (REG 06h[7]) |
| Status Bits: | CHGCMP (REG 01h[4]) |

Table 15. SUMMARY OF TIMERS

| Name | Control Register | Range (Minutes) | Default |
|-------------|------------------|--------------------|-------------|
| Pre-Charge | 19h[4:3] | 100 sec to 36 min. | On, 36 min. |
| Fast Charge | 19h[2:0] | 4 hr to 16 hr | On, 8 hr |
| Watch Dog | 19h[6] | 100 sec | Off |
| Top – Off | 1Bh[2:0] | 10 min. to 70 min. | On, 30 min. |

Thermal Regulation

When the IC's junction temperature reaches the programmable Thermal Regulation threshold, T_{REGTH} , set by TREGTH (REG (0Fh[6:5]), the thermal regulation loop reduces charge current to the lowest IOCHRG (REG 12h[5:0]) setting (200 mA) to prevent overheating.

The device will attempt to charge the battery at a maximum average current while maintaining the die temperature at or below T_{REGTH} . This is accomplished by stepping I_{OCHRG} from the lowest IOCHRG setting back up to the programmed IOCHRG setting. If T_{REGTH} is again reached the process is repeated.

During Thermal Regulation, the IBUSLIM and IINLIM input current limit settings are retained in order to support the system load from a valid power source.

APPLICABLE STATUS AND INTERRUPT

| Pins: | /INT |
|-----------------|----------------------|
| Interrupt Bits: | ICTEMP (REG (06h[4]) |
| Status Bits: | TEMPFB (REG 02h[4]) |

Thermal Shutdown

If the junction temperature increases beyond the Thermal Shutdown threshold, $T_{SHUTDOWN}$, charging is suspended and the buck converter is disabled. While suspended, all timers stop and registers do not reset. Charging resumes only after the die temperature falls below T_{REGTH} where I_{OCHRG} will be stepped back up to the programmed IOCHRG setting.

APPLICABLE STATUS AND INTERRUPT

| Pins: | /INT /STAT |
|-----------------|----------------------|
| Interrupt Bits: | ICTEMP (REG (06h[4]) |
| Status Bits: | TEMPSD (REG (02h[5]) |

Register Reset Conditions

As an added layer of safety, the I²C control bits automatically reset to their default values under certain situations. Refer to Table 16 for details.

Table 16. REGISTER RESET SUMMARY

| Reset Condition Description | Registers that are Reset | Behavior After Reset Event | |
|---|---|---|--|
| VBUS/VIN plug in (from no input connected) and any $\rm V_{BAT}$ voltage | VBUSLIM and VINLIM only | VBUSLIM = 4.56 V VINLIM = 4.56 V | |
| VBUS/VIN plug in (from no input connected) and V_{BAT} < V_{SHORT} | All registers <u>except</u> STATUS, and IN TERRUPT | Pre-Charge with default settings; Q4 in Linear Region | |
| VBUS/VIN plug in (from no input connected) and $V_{SHORT} < V_{BAT} < V_{BATMIN}$ | All registers <u>except</u> SAFETY, STATUS, and INTERRUPT | Pre-Charge with default settings; Q4 in Linear Region | |
| V_{BAT} falls below V_{BATMIN} with an input connected | HZMODE bit only | Pre-Charge at programmed settings; Q4 in Linear Region | |
| Battery Removal Detected (input connected) | VFLOAT, IOCHRG, PRECHG, ITERM, SAFETY | Buck regulates at V _{FLOAT} ; Q4 Off | |
| Pre-Charge / Fast Charge Safety Timer Ex- piration | | Buck regulates at 4.35 V; Charging stops; Q4 Off | |
| Charge Mode Watchdog Timer Expiration (WDTEXP="0") | | Charging continues with default settings; Q4 On | |
| Charge Mode Watchdog Timer Expiration (WDTEXP= "1") | All registers <u>except</u> SAFETY, STATUS, and | Buck regulates at 4.35 V; Charging stops; Q4 Off | |
| OTG Boost Mode Watchdog Timer Expira- tion | INTERRUPT | Boost Off; Q3 Off; Q4 On | |
| Set RESET (REG 0Fh[7]) = "1" (Charge Mode) | | Charging continues with default settings; Q4 On | |
| Set RESET (REG 0Fh[7]) = "1" (OTG Boost Mode) | | Boost Off; Q3 Off; Q4 On | |

JEITA Charging

The IC reduces I_{OCHRG} and V_{FLOAT} if the measured battery temperature is outside of the fast charging limits (Between T2 to T3) as described in the JEITA specification. There are four battery temperature thresholds that change battery charger operation: T1, T2, T3, and T4.

The IC first measures the NTC immediately prior to entering any PWM charging state, and then measures the NTC once per second, updating the result in the NTC4–NTC1 bits (REG 18h[3:0]).

The Host processor can disable JEITA charging reduction by setting the TEMPDIS (REG 18h[5]) bit to "1".

To disable the thermistor circuit, tie the NTC pin to GND. This also disables the REF output. Before enabling the charger, the IC tests to see if NTC is shorted to GND. If NTC is shorted to GND, the NTCGND monitor bit (REG 21h[2]) will be set, no thermistor readings will take place, the NTCOK bit (REG 18h[4]) and NTC4–NTC1 (REG 18h[3:0]) bits will be reset.

APPLICABLE STATUS AND INTERRUPTS

| Pins: | /INT |
|-----------------|---|
| Interrupt Bits: | BATTEMP (REG 06h[3]) |
| Status Bits: | JEITA (REG 02h[3]) TBAT (REG 02h[2]) |

Table 17. BATTERY TEMPERATURE THRESHOLDS, FOR USE WITH 10 K NTC, B = 3380, and $R_{REF} = 10$ K

| Threshold | Т _{ВАТ} (°С) | % of VREF |
|-----------|-----------------------|-----------|
| T1 | 0°C | 73.9 |
| T2 | 10°C | 64.6 |
| Т3 | 45°C | 32.9 |
| T4 | 60°C | 23.3 |

| T _{BAT} (°C) | IOCHRG | V _{FLOAT} | NTC4-1 | JEITA | TBAT | Notes |
|-----------------------|------------------------|-----------------------------|--------|-------|------|--|
| Below T1 | Charging d | lisabled (Q4 open) | 0000 | 1 | 1 | |
| Between T1 and T2 | I _{OCHRG} / 2 | V _{FLOAT} – 200 mV | 0001 | 1 | 0 | If IOCHRG is programmed to less than 400 mA, the charge current will be limited to 200 mA. |
| Between T2 and T3 | IOCHRG | V _{FLOAT} | 0011 | 0 | 0 | |
| Between T3 and T4 | I _{OCHRG} / 2 | V _{FLOAT} – 200 mV | 0111 | 1 | 0 | If IOCHRG is programmed to less than 400 mA, the charge current will be limited to 200 mA. |
| Above T4 | Charging d | isabled (Q4 open) | 1111 | 1 | 1 | |

Table 18. ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Table 19. TEMPERATURE THRESHOLD WITH VARIOUS THERMISTORS, R_{REF} = R_{THRM} AT 25 $^\circ\text{C}$

| Parameter | | Various Thermistors | | |
|-------------------------|------|---------------------|------|------|
| R _{THRM(25°C)} | 10K | 10K | 47K | 100K |
| β | 3380 | 3940 | 4050 | 4250 |
| T1 | 0°C | 3°C | 6°C | 8°C |
| T2 | 10°C | 12°C | 13°C | 14°C |
| Т3 | 45°C | 42°C | 41°C | 40°C |
| T4 | 60°C | 55°C | 53°C | 51°C |

V_{BUS} Over–Voltage Protection

When $V_{BUS} > V_{BUSOVP}$, the IC stops switching, fully enhances Q4 to support SYS load, and issues an interrupt.

When V_{BUS} falls below $V_{BUSOVP} - V_{BUSOVP(HYS)}$, charging resumes after VBUS is revalidated, where another interrupt is issued.

If $V_{BUS} > V_{BUSOVP}$ VIN cannot be used as a charging source.

APPLICABLE STATUS AND INTERRUPT

| Pins: | /BUSOK /INT /STAT |
|-----------------|---|
| Interrupt Bits: | VBUSINT (REG 04h[5]) OVPINPUT (REG 06h[6]) |
| Status Bits: | INPUTOVP (REG 02h[6]) |

VIN Over-Voltage Protection

When $V_{IN} > V_{INOVP}$, the IC stops switching, opens Q5, fully enhances Q4 to support SYS load, and issues an interrupt.

When V_{IN} falls below $V_{INOVP} - V_{INOVP(HYS)}$, charging resumes after VIN is revalidated, where another interrupt is issued.

If $V_{IN} > V_{INOVP}$, VBUS cannot be used as a charging source.

APPLICABLE STATUS AND INTERRUPT

| /INOK /INT /STAT |
|--|
| VININT (REG 04h[6]) OVPINPUT (REG 06h[6]) |
| INPUTOVP (REG 02h[6]) |
| |

VBAT Over-Voltage Protection

The FLOAT voltage regulation loop prevents V_{BAT} from overshooting V_{FLOAT} by more than $V_{BAT OVP}$ if the battery is removed during Charge Mode with TE (REG 0Eh[3]) = "0" or "1".

Additionally, if the battery is removed during Charge Mode and TE = "0", the IC will remain in Charge Mode. Then if a battery is inserted that is charged to a voltage higher than 1.05 * V_{FLOAT} ;

- 1. PWM pulses stop while $V_{BAT} > V_{FLOAT}$.
- 2. HIVBAT (REG 20h[3]) monitor bit set to "1".
- 3. BATFET (Q4) remains on to support the
- system, thus removing excess charge from the battery.
Battery Absence Detection while Charging

The IC can detect the presence, absence, or removal of a battery if TE (REG 0Eh[3]) = "1" and CE# = "0". During normal charging, once $V_{BAT} = V_{FLOAT}$ and the charge current falls below I_{TERM} , the PWM charger continues to provide power to SYS, the BATFET (Q4) is turned off except to support Supplemental Mode, and the IC enters Idle State. It then turns on a battery discharge current, I_{DETECT} , for t_{DETECT}. If V_{BAT} is still above $V_{FLOAT} - V_{RCHG}$, the battery is present and the NOBAT bit is maintained at "0". If V_{BAT} is below $V_{FLOAT} - V_{RCHG}$, the battery is absent and the IC resets all charging related registers to their default values (FLOAT, IOCHRG, PRECHG, and ITERM) and issues an interrupt.

By default the IC will retry Battery Absence Detection every t_{INT} (2.1 s) unless NOBATOP (REG 0Eh[4]) = "0". APPLICABLE STATUS AND INTERRUPT

| Pins: | /INT |
|-----------------|---------------------|
| Interrupt Bits: | BATINT (REG 04h[0]) |
| Status Bits: | NOBAT (REG. 00h[0]) |

Battery Under-Voltage Protection

The battery voltage falling below V_{SHORT} during battery charging indicates that a catastrophic event has occurred on the BAT pin. If the battery voltage drops below V_{SHORT} during charging, the IC will automatically disable the BATFET (Q4) to stop current flow to the battery node, and issue an interrupt. The IC enters the Idle State where the buck converter continues to provide power to the system. If the battery voltage recovers above V_{SHORT}, Q4 remains off (Idle State is maintained) and BATSHORT is set to "1". This implementation is intended to lock out battery charging. The only way to restart charging is to first remove V_{SOURCE}, and then reconnect a valid VIN or VBUS power source.

APPLICABLE STATUS AND INTERRUPT

| Pins: | /INT /STAT |
|-----------------|-----------------------|
| Interrupt Bits: | SHORTBAT (REG 06h[5]) |
| Status Bits: | LOIBAT (REG 01h[7]) |
| Monitor Bits: | BATSHORT (REG 20h[4]) |

BATFET (Q4) Over-Current Protection

In order to prevent damage to the charger and battery due to a potentially dangerous fault on the SYS pin, the IC prevents its internal BATFET(Q4) from allowing excessive battery discharge current for more than T_{SCQUAL} . The Q4 short circuit current limit ($I_{LIMQ4SC}$) is set for 9 A (typical). If the battery is connected and the discharge current through Q4 exceeds $I_{LIMQ4SC}$ for more than the t_{SCQUAL} deglitch time (1 ms), Q4 will be disabled for the $t_{SCRECOV}$ recovery time of 2 seconds. Once the 2 seconds has passed, Q4 will turn on and check if the over–current condition still exists. If the over–current condition still exists, Q4 will be disabled again for 2 seconds. This cycle will repeat until the over–current condition is removed.

APPLICABLE STATUS AND INTERRUPT

Pins: /INT Interrupt Bits: BATOCP (REG 06h[1])

Safety Register

The IC contains a SAFETY (REG 1Ah) register that prevents the values in FLOAT (REG 11h[7:0]) and IOCHRG (REG 12h[5:0]) from being set to unsafe levels. The VSAFE (REG 1Ah[7:4]) and ISAFE (REG 1Ah[3:0]) register bits within the SAFETY register set a maximum programmable value for FLOAT and IOCHRG.

After V_{BAT} rises above V_{SHORT} , the SAFETY register is loaded with its default value and may be changed on the first write to the SAFETY register and only before writing to any other register. The VSAFE and ISAFE values must be written to the register at the same time. After first writing to the SAFETY register or any other register, the SAFETY register is locked.

The SAFETY register will reset to default values when $V_{BAT} < V_{SHORT}$. The SAFETY register does not reset if the Safety Timer or WDT timer expires.

Ship Mode

Ship Mode is a state where the BATFET (Q4) is configured to isolate the battery from the system load to minimize battery discharge current to the system. This mode of operation is useful for preserving the battery life of a mobile device during extended shipping and storage durations. Ship Mode is also useful for production testing of a mobile device without having to drain the battery.

The /SHIP pin controls entry into and exit out of Ship Mode. To enter Ship Mode, the /SHIP pin must be held LOW for $t_{SHIPENTER}$. To exit Ship Mode, /SHIP must be first released and then held LOW for $t_{SHIPEXIT}$. This configuration prevents accidental entry into and exit out of Ship Mode with a single key press of a mobile device's power button. An alternate method for exiting Ship Mode is to reapply a valid source to VBUS or VIN. Once the source has been validated, the charger IC will exit Ship Mode.

Ship Mode can also be programmed using the PPOFF (REG 0Fh[1]) and PPOFFSLP (REG 0Fh[2]) control bits. Setting PPOFF to "1" will disable Q4 and isolate the battery from the system load. As long as there is input power to maintain the charger's I²C port, setting PPOFF back to "0" will re–enable Q4.

Setting PPOFFSLP to "1" while there is input power connected will disable Q4 once power is removed from VBUS and VIN. Once power is reapplied, the charger IC will automatically enable Q4.

The PPOFF and PPOFFSLP bits are automatically controlled by the /SHIP pin. When entering Ship Mode using the /SHIP pin, PPOFF and PPOFFSLP are set to "1". When exiting Ship Mode using the /SHIP pin, PPOFF and PPOFFSLP are reset to "0".

Hardware Reset

This is a factory configurable option of the /SHIP pin.

The Ship Mode feature can be disabled and the /SHIP pin can also be reconfigured to perform a Hardware Reset. When the /SHIP pin is held LOW for 8 s it will disable Q4 for 512 ms and discharge SYS using an internal 200 Ω pull-down. After the 512 ms period has passed, Q4 is re-enabled and the 200 Ω pull-down is disconnected from SYS. This feature allows for a quick system restart of a mobile device with an embedded battery by eliminating the time needed for the battery to self-discharge to the point where its protection switch opens.



Figure 48. Ship Mode Control

BOOST CIRCUIT DETAILS

Refer to: Boost State Diagram

Q1 and Q2 operate as a synchronous boost regulator to provide power to the VBUS pin for USB-On-the-Go (OTG) applications using the battery as its input. The Boost output voltage can be programmed using the VBOOST (REG 1Ch[3:0]) bits.

Boost Enable and Programming

Boost Mode can be enabled by setting the BOOSTEN (REG 1Ch[5]) bit to "1". BOOSTEN starts the boost operation, regulating VBOOST (REG1Eh[3:0]) at the PMID node. To provide power out to the VBUS pin, the OTG bit (REG 1Ch[6]) must also be set to "1". Whenever boost mode is disabled, either by a fault or writing BOOSTEN="0", the OTG bit will be automatically reset to "0".

The HZMODE (REG 0Eh[1]) bit will be ignored when the boost is enabled. The device will return to High Impedance Mode when BOOSTEN is set back to "0" or the DIS pin is raised HIGH.

The boost should not be enabled with a valid VIN present.

If a source is plugged into VIN while the boost is already running, VIN will be ignored (Q5 will remain off) until the boost is disabled.

Boost Mode and Timer Operation

It is recommended to enable the watchdog timer (t_{WD}) by setting WDEN (REG 19h[6]) bit to "1" to ensure that the host processor is controlling Boost Mode operation. The TMRRST (REG 19h[7]) bit must be set by the host before the t_{WD} timer times out. If t_{WD} times out in Boost Mode, the BOOSTEN and OTG bits are reset, and an interrupt is issued.

APPLICABLE STATUS AND INTERRUPT

| Pins: | /INT |
|-----------------|-----------------------|
| Interrupt Bits: | BSTWDTTO (Reg.05h[1]) |
| Status Bits: | BOOST (REG 01h[1]) |

Boost PWM Control

The IC uses a computed off-time and a regulated on-time (with an enforced minimum) to regulate V_{PMID} . The regulator achieves excellent transient response by employing current-mode modulation.

Since V_{BOOST} is regulated at the PMID node, V_{BUS} will exhibit a load-line equal to the $R_{DS(ON)}$ of Q3.

Boost PFM Mode

If $V_{PMID} > VREF_{BOOST}$ (nominally 5.00 V) when the minimum off-time has ended, the regulator enters PFM Mode. Boost pulses are inhibited until $V_{PMID} < VREF_{BOOST}$. The minimum on-time is increased to enable the output to pump up sufficiently with each PFM boost pulse. Therefore the regulator behaves like a constant on-time regulator, with the bottom of its output voltage ripple at V_{BOOST} in PFM Mode.

Boost Startup

As the device should be in the Standby State when the boost is enabled, the BATFET (Q4) will already be enabled to support the system.

Soft-Start State

By setting BOOSTEN = "1", the boost regulator begins switching with a reduced peak current limit of 50% of its normal current limit ($I_{LIMPK(BST)}$). The output slews up until V_{PMID} is within 5% of its setpoint (V_{BST}); at which time, the regulation loop is closed and the current limit is set to 100%.

If the output fails to achieve 95% of its setpoint within 128 µs, the current limit is increased to 100%. If the output fails to achieve 95% of its setpoint after an additional 1 ms period, a boost fault state is initiated and an interrupt is issued.

APPLICABLE STATUS AND INTERRUPT

Pins: /INT Interrupt Bits: BSTFAIL (Reg.05h[3])

Short Check State

The OTG (REG 1Ch[6]) control bit needs to be set in order to pass the boost output voltage (PMID) to V_{BUS} for USB On-the-Go operation. Once OTG is set to "1", the Short Check state enables a resistor from PMID to V_{BUS} and waits for V_{BUS} to rise to about 1.5 V before proceeding with the VBUS Connect State. This prevents high current drain from the battery, which could occur if Q3 is turned on into a short circuit.

If V_{BUS} fails to rise above 1.5 V within 8 ms, an interrupt is issued, the resistor is disconnected between PMID and VBUS, and V_{PMID} remains regulated to V_{BOOST} .

APPLICABLE STATUS AND INTERRUPT

Pins:

Interrupt Bits: OTGOCP (REG 06h[2])

/INT

If the VBUS fault is removed, Short Check State will automatically retry after 2 seconds, and then proceed to the VBUS Connect State

VBUS Connect State

If a short is not detected on V_{BUS} during the Short Check State, Q3 will fully turn on and provide a low impedance path between PMID and VBUS. The resistor between PMID and VBUS is left connected. This state ends when V_{BUS} rises above V_{PMID} –400 mV within a 1 ms period, at which point boost regulation is achieved and a Status bit is set.

APPLICABLE STATUS AND INTERRUPT

Status Bits: BOOST (REG 01h[1])

If V_{BUS} fails to reach V_{PMID} -400 mV within 1 ms, a boost fault state is initiated, and an interrupt is issued.

APPLICABLE STATUS AND INTERRUPT

| Pins: | /INT |
|-----------------|----------------------|
| Interrupt Bits: | BSTFAIL (REG 05h[3]) |

Boost State

This is the normal operating mode of the boost regulator.

The minimum t_{OFF} is proportional to $\frac{V_{IN}}{V_{OUT}}$, which keeps the regulator's switching frequency relatively constant in CCM.

Boost Alert

When the battery voltage falls below 3.0 V an interrupt is issued warning that the battery is depleted. The /INT pin is pulled low to alert the processor of the condition. BOOSTEN is not reset.

APPLICABLE STATUS AND INTERRUPT

| Pins: | /INT |
|-----------------|---------------------|
| Interrupt Bits: | VBATLV (REG 05h[0]) |
| Status Bits: | BATLO (REG 01h[0]) |

Boost Faults

If a BOOST fault occurs:

- 1. The /INT Pin is pulled low for Interrupt faults.
- 2. BOOSTEN bit is reset to "0". OTG bit is reset to "0". Q3 is opened.
- 3. BOOST status bit is cleared.
- 4. The power stage is in High–Impedance Mode.
- 5. Interrupt bits are set per Table 20.

BOOSTEN is reset on boost faults. Boost Mode can only be re-enabled by setting the BOOSTEN bit.

Boost Shutdown

When the boost regulator is shut down (BOOSTEN = "0"), current flow is prevented from V_{BAT} to V_{BUS} , as well as reverse flow from V_{BUS} to V_{BAT} .

| Fault Name | Fault Bit | Fault Description |
|------------|---|--|
| BSTOVP | REG 05h[5] | V _{PMID} > V _{BOOST_OVP} |
| BSTFAIL | FAILREG 05h[3]VPMID fails to achieve the voltage required to advance to the next state or sustained (> 50 μs) current limit during the BST state | |
| BATUVL | REG 05h[2] | V _{BAT} < UVLO _{BST} |
| BSTTSD | REG 05h[4] | Thermal Shutdown (T > T _{REGTH}) |
| BSTWDTTO | REG 05h[1] | Boost Watch Dog Timer Fault |

Table 20. FAULT BITS DURING BOOST MODE

LDO

The FAN5451x provides a 4.95 V (typical), 10 mA LDO that is sourced by PMID. The LDO is automatically enabled 32 ms after V_{BUS} or V_{IN} Plug In.

The LDO can be disabled by setting LDO_OFF (REG 0Dh[5]) to "1". The LDO output voltage can be programmed using the VLDO (REG 0Dh[4:3]) bits.

Whenever the FAN5451x is operating in boost mode (BOOSTEN = "1"), the LDO will be disabled. When the LDO is disabled, an internal switch pulls the output low through a 1.2 k Ω pull-down resistor.

LDO and GPO Configurations

FAN54511A, FAN54511AP, FAN54513A only

The LDO output sources the high side of the GPO1 and GPO2 CMOS output drivers, while the gate of the output drivers are controlled by the GPO2 (REG 0Dh [7]) and GPO1 (REG 0Dh [6]) control bits. LDO and GPO1 are enabled by default.

I²C INTERFACE

The FAN5451x's serial interface is compatible with Standard, Fast, Fast Plus, and High–Speed Mode I2C bus specifications. The FAN5451x's SCL line is an input and its SDA line is a bi–directional open–drain output; it can only pull down the bus when active. The SDA line only pulls low during data reads and when signaling ACK. All data is shifted in MSB (bit 7) first.

Slave Address

Table 21. I²C Slave Address Byte

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|---|---|---|---|---|---|-----|
| 1 | 1 | 0 | 1 | 0 | 1 | 1 | R/W |

In hex notation, the slave address assumes a "0" LSB. The hex slave address is D6H (8–bit write address) for all parts in the family. Other slave addresses can be accommodated upon request. Contact your ON Semiconductor representative.

Bus Timing

As shown in Data Transfer Timing, data is normally transferred when SCL is low. Data is clocked in on the rising edge of SCL. Typically, data transitions shortly at or after the falling edge of SCL to allow ample time for the data to set up before the next SCL rising edge.



Figure 49. Data Transfer Timing

Each bus transaction begins and ends with SDA and SCL HIGH. A transaction begins with a START condition, which is defined as SDA transitioning from 1 to 0 with SCL HIGH.



A transaction ends with a STOP condition, which is defined as SDA transitioning from "0" to "1" with SCL high.



During a read from the FAN5451x, the master issues a Repeated Start after sending the register address and before resending the slave address. The Repeated Start is a 1-to-0 transition on SDA while SCL is high.

High-Speed (HS) Mode

The protocols for High–Speed (HS), Low–Speed (LS), and Fast–Speed (FS) Modes are identical except the bus speed for HS Mode is 3.4 MHz. HS Mode is entered when the bus master sends the HS master code 00001XXX after a start condition. The master code is sent in Fast or Fast Plus Mode (maximum 1 MHz clock); slaves do not ACK this transmission. The master then generates a repeated start condition that causes all slaves on the bus to switch to HS Mode. The master then sends I2C packets, as described above, using the HS Mode clock rate and timing.

The bus remains in HS Mode until a stop bit is sent by the master. While in HS Mode, packets are separated by repeated start conditions.



READ AND WRITE TRANSACTIONS

Table 22. BIT DEFINITIONS

| Symbol | Definition | | | | |
|--------|--|--|--|--|--|
| S | START | | | | |
| А | ACK. The slave drives SDA to 0 acknowledge the preceding packet. | | | | |
| Ā | NACK. The slave sends a 1 to NACK the preceding packet. | | | | |
| R | REPEATED START | | | | |
| Р | STOP | | | | |



Figure 53. Write Transaction



Figure 54. Read Transactions

SOLUTION DESIGN RECOMMENDATION



Figure 55. Recommended Component Placement and Routing



Figure 56. Recommended GND Connections

REGISTER AND BIT DESCRIPTIONS

The default states of the registers are with only the battery connected (VBUS and VIN not connected).

Table 23. I²C REGISTER MAP

| REG NAME | ADR | DEFAULT | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|--------------------|-----|-----------|--------------------------------------|-----------|-----------|----------|------------|----------|----------|----------|
| STATUS 0 | 00h | 1000_0010 | RESERVED | VINPWR | VBUSPWR | PWROK | STAT | PRE | SLEEP | NOBAT |
| STATUS 1 | 01h | 0000_0000 | LOIBAT | CHG | DET | CHGCMP | TOCHG | DIVC | BOOST | BATLO |
| STATUS 2 | 02h | 0000_0000 | INPUTSEL | INPUTOVP | TEMPSD | TEMPFB | JEITA | TBAT | WDTTO | TMRTO |
| INT 0 | 04h | 0000_0000 | VALFAIL | VININT | VBUSINT | VLOWTH | CHGEND | CHGMOD | WKBAT | BATINT |
| INT 1 | 05h | 0000_0000 | IBATLO | RCHGN | BSTOVP | BSTTSD | BSTFAIL | BATUVL | BSTWDTTO | VBATLV |
| INT 2 | 06h | 0000_0000 | TOCMP | OVPINPUT | SHORTBAT | ICTEMP | BATTEMP | OTGOCP | BATOCP | TIMER |
| MINT 0 | 08h | 0000_0000 | MVALFAIL | MVININT | MVBUSINT | MVLOWTH | MCHGEND | MCHGMOD | MWKBAT | MBATINT |
| MINT 1 | 09h | 0000_0000 | MIBATLO | MRCHGN | MBSTOVP | MBSTTSD | MBSTFAIL | MBATUVL | RESERVED | MVBATLV |
| MINT 2 | 0Ah | 0000_0000 | MTOCMP | MOVPINPUT | MSHORTBAT | MICTEMP | MBATTEMP | MOTGOCP | MBATOCP | MTIMER |
| CONTROL 0 | 0Ch | 0011_1111 | RESE | RVED | | VLOWV | | | VBATMIN | |
| CONTROL 1 | 0Dh | 0101_0111 | GP02 | GPO1 | LDO_OFF | VL | DO | RESERVED | VS | YS |
| CONTROL 2 | 0Eh | 0001_1100 | CONT | RESERVED | RCHGDIS | NOBATOP | TE | TOEN | HZMODE | RESERVED |
| CONTROL 3 | 0Fh | 0100_0000 | RESET | TRE | GTH | RESE | RVED | PPOFFSLP | PPOFF | CE# |
| VFLOAT | 11h | 0110_1001 | | | | FLO | AT | | | |
| IOCHRG | 12h | 0001_0000 | RESE | RVED | | | IOCH | IRG | | |
| IBAT | 13h | 1001_1000 | | ITEF | RM | | PRECHG | | | |
| IBUS | 14h | 0001_0000 | RESERVED | | | | IBUSLIM | | | |
| VBUS | 15h | 0010_0100 | RESE | RVED | VBUS | SOVP | | VBUSLIM | | |
| IIN | 16h | 0001_1011 | RESERVED | | | | IINLIM | | | |
| VIN | 17h | 0001_0100 | RESE | RVED | VIN | OVP | | VINLIM | | |
| NTC | 18h | 0000_1111 | RESE | RVED | TEMPDIS | NTCOK | NTC4 | NTC3 | NTC2 | NTC1 |
| TIMER | 19h | 0001_1011 | TMRRST | WDEN | RESERVED | PRE | TMR | | FCTMR | |
| SAFETY | 1Ah | 1111_1111 | | | | SAFE | TY | | | |
| TOPOFF | 1Bh | 0000_0011 | | RESEF | RVED | | TO_BDETDIS | | TOTMR | |
| BOOST | 1Ch | 0001_0010 | RESERVED OTG BOOSTEN RESERVED VBOOST | | | | | | | |
| DPLUS | 1Fh | 0000_0000 | FORCEDET | FORCEDET | | | RVED | | | SETTMR0 |
| MONITOR 0 | 20h | 1000_0110 | ITERMCMP | VBATCMP | VLOWVCMP | BATSHORT | HIVBAT | IBUS# | ICHG# | CV |
| MONITOR 1 | 21h | 1010_0XXX | RESERVED | PMIDVBAT | PPON | BUCKON | ISRCCMP | NTCGND | DISPIN | ILIMPIN |
| IC_INFO | 2Dh | 10XX_XXXX | VENDOR CODE | | | PN | | REV | | |
| FEATURE CONTROL | 30h | 0010_0000 | WDTEXP | RESERVED | DIVCON | DISREF | RESE | RVED | RESE | RVED |

Table 24. I²C REGISTER DESCRIPTIONS

| | STATU | S 0 | | Register Address: 00h Default Value = 1000 001 | | | | | |
|-----|----------|-------|------|--|--|--|--|--|--|
| Bit | Name | Value | Туре | Description | | | | | |
| 7 | RESERVED | 1 | R | Reserved. This bit should always read "1". | | | | | |
| 6 | VINPWR | 0 | R | A "1" indicates that an input source voltage at V _{IN} has risen above V _{SOURCE(RISE)} and passed validation, and a valid VBUS is not present. To maintain a "1" V _{SOURCE(FALL)} < V _{IN} < V _{INOVP} and V _{IN} > V _{BAT} + V _{SLP} . VINPWR will not be set to "1" if VBUSPWR = "1". | | | | | |
| 5 | VBUSPWR | 0 | R | A "1" indicates that an input source voltage at passed validation. To maintain a "1" $V_{SOURCE(FALL)} < V_{BUS} < V_{BUSOVP}$ and V_{BUS} | | | | | |
| 4 | PWROK | 0 | R | If HZ state is entered while PWROK is set to " PWROK will not reset to "0" until after the sou | A "1" indicates that $V_{BAT} > V_{LOWV}$ during charging. If HZ state is entered while PWROK is set to "1" and then V_{BAT} falls below V_{LOWV} , PWROK will not reset to "0" until after the source is re–validated and the IC returns to Charge Mode. Validation occurs whenever the part exits HZ State. | | | | |
| 3 | STAT | 0 | R | A "1" indicates the /STAT pin is pulled low whe to "0" during Top-Off charging. | en charging is being performed. This bit goes | | | | |
| 2 | PRE | 0 | R | A "1" indicates that the charger is in Pre–Charge mode and a "0" indicates it is not. In con- junction with the STAT (REG 00h[3]) bit, the system processor can determine the type of charging being performed. | | | | | |
| 1 | SLEEP | 1 | R | A "1" indicates that the charger is in sleep mode. Sleep mode is entered when the highest available input source voltage drops below the higher of $V_{BAT} + V_{SLP}$ or $v_{SOURCE(FALL)}$. | | | | | |
| 0 | NOBAT | 0 | R | A "1" indicates that the IC has determined the | re is no battery connected. | | | | |
| | STATU | S 1 | | Register Address: 01h | Default Value = 0000 0000 | | | | |
| Bit | Name | Value | Туре | Descri | ption | | | | |
| 7 | LOIBAT | 0 | R | A "1" indicates that the battery is present but t threshold when TE= "0" or TOEN = "1". | he current has fallen below the I_{TERM} | | | | |
| 6:5 | CHGDET | 00 | R | Identifies the type of charger adapter connected to the VBUS input after adapter detection is completed. (FAN54510A, FAN54512A only). Binary Adapter Type 00 Detection not completed 01 SDP 10 CDP 11 DCP | | | | | |
| 4 | CHGCMP | 0 | R | A "1" indicates that the battery is charged (I _{BAT} < _{ITERM}) and that charging has completed when TE = "1". This bit remains "0" during Top–Off charging. | | | | | |
| 3 | TOCHG | 0 | R | A "1" indicates Top-Off charging mode. | | | | | |
| 2 | DIVC | 0 | R | A "1" indicates that the Dynamic Input Voltage Control loop is active. If DIVC = "1", the INPUTSEL (REG 02h[7]) status bit indicates whether the V _{BUSLIM} or V _{INLIM} voltage control loop is active. | | | | | |
| 1 | BOOST | 0 | R | A "1" indicates the device is in boost mode. | | | | | |
| 0 | BATLO | 0 | R | A "1" indicates that V_{BAT} < 3.0 V during Boost | Operation only. | | | | |

Table 24. I²C REGISTER DESCRIPTIONS (continued)

| | STATU | S 2 | | Register Address: 02h Default Value = 0000 | | | | |
|-----|----------|-------|------|--|---|--|--|--|
| Bit | Name | Value | Туре | Description | | | | |
| 7 | INPUTSEL | 0 | R | Indicates which input is routed to PMID whenever a valid source is connected to VBUS o VIN. Binary Input 0 VBUS 1 VIN | | | | |
| 6 | INPUTOVP | 0 | R | A "1" indicates that V_{BUS} and/or V_{IN} is higher than its OVP threshold. Switching is stopped to protect the IC and the BATFET (Q4) is turned on to support the system load. If INPUTOVP = "1", the INPUTSEL status bit (REG 02h[7]) state indicates whether the OVP condition exists on V_{BUS} or V_{IN} . | | | | |
| 5 | TEMPSD | 0 | R | A "1" indicates the charger is in thermal shutd | own. | | | |
| 4 | TEMPFB | 0 | R | A "1" indicates the charger is in thermal regula | ation. | | | |
| 3 | JEITA | 0 | R | A "1" indicates the battery temperature is outs during battery charging, charge current and fid has stopped, and NTC (REG 18h[3:0]) = "000 See (REG 18h[5:0]) for details on NTC operat | pat voltage have been reduced or charging 0", "0001", "0111", or "1111". | | | |
| 2 | TBAT | 0 | R | A "1" indicates the battery temperature is unsafe and, therefore, charging has been stopped and NTC (REG 18h[3:0]) = "0000" or "1111" See (REG 18h[5:0]) for details on NTC operation. | | | | |
| 1 | WDTTO | 0 | R | A "1" indicates the 100sec Watch Dog Timer has timed out in Charge Mode. When the watch dog timer expires, registers are reset to their default values and the WDEN (REG 19h[6]) control bit is cleared. Setting WDEN (REG 19h[6]) = "1" or a re-insertion of VBUS or VIN will reset WDTTO back to "0". | | | | |
| 0 | TMRTO | 0 | R | A "1" indicates the safety timer expired during Pre-Charge or Fast Charge. A re-insertion of VBUS or VIN will reset WDTTO back to "0". | | | | |
| | INT 0 | | | Register Address: 04h | Default Value = 0000 0000 | | | |
| Bit | Name | Value | Туре | Descri | ption | | | |
| 7 | VALFAIL | 0 | RC | A "1" indicates that V_{BUS} or V_{IN} validation failed | ed. | | | |
| 6 | VININT | 0 | RC | $\label{eq:VIN Plug In: A "1" indicates $V_{IN} > V_{SOURCE(RISE)}$. The bit will remain "0" if VBUS is already present. VIN Plug Out: A "1" indicates $V_{IN} < V_{SOURCE(FALL)}$ or $V_{IN} < V_{BAT}+V_{SLP}$. VBUS Plug Out with VIN Present: A "1" indicates that $V_{IN} > V_{SOURCE(RISE)}$. This VIN interrupt will not occur, though, until $V_{BUS} < V_{SOURCE(FALL)}$ or $V_{BUS} < V_{BAT}+V_{SLP}$. }$ | | | | |
| 5 | VBUSINT | 0 | RC | VBUS Plug In: A "1" indicates V _{BUS} > V _{SOUR} VBUS Plug Out: A "1" indicates V _{BUS} < V _{SOU} | CE(RISE)· RCE(FALL) or V _{BUS} < V _{BAT} +V _{SLP} . | | | |
| 4 | VLOWTH | 0 | RC | A "1" indicates the battery voltage has risen above or fallen below the V_{LOWV} threshold during charging or $V_{BAT} > V_{LOWV}$ at the start of charging. The interrupt will also occur at Plug Out if $V_{BAT} > V_{LOWV}$. | | | | |
| 3 | CHGEND | 0 | RC | A "1" indicates that the device has completed a normal charge cycle where I_{BAT} has fallen below the I_{TERM} threshold if TE = "1". If configured to do so, the IC may continue charging in Top Off with CHGEND = "1". | | | | |
| 2 | CHGMOD | 0 | RC | A "1" indicates that the charging mode has changed between Pre–Charge and Fast Charge modes. | | | | |
| 1 | WKBAT | 0 | RC | A "1" indicates the battery is below the V _{BATMIN} threshold set in VBATMIN (REG 0Ch[2:0]) at Plug In. | | | | |
| 0 | BATINT | 0 | RC | A "1" indicates that the IC has determined the See NOBAT (REG 00h[0]) status bit. | battery presence has changed state. | | | |

Table 24. I²C REGISTER DESCRIPTIONS (continued)

| | INT | 1 | | Register Address: 05h | Default Value = 0000 0000 | | | |
|-----|----------|-------|------|---|---|--|--|--|
| Bit | Name | Value | Туре | Description | | | | |
| 7 | IBATLO | 0 | RC | A "1" indicates that the charging current has risen above or fallen below I_{TERM} when TE = "0". The LOIBAT (REG 01h[7]) status bit should also be read to determine if the actual charging current is above or below the I_{TERM} threshold. | | | | |
| 6 | RCHGN | 0 | RC | A "1" indicates that the battery voltage has fal has completed. | llen by $V_{\mbox{RCHG}}$ below $V_{\mbox{FLOAT}}$ after charging | | | |
| 5 | BSTOVP | 0 | RC | A "1" indicates that VBUS has risen above the | e boost OVP threshold. | | | |
| 4 | BSTTSD | 0 | RC | A "1" indicates that the IC junction temperature threshold, T _{REGTH} , during boost operation. | re has exceeded the temperature shutdown | | | |
| 3 | BSTFAIL | 0 | RC | V_{BUS} fails to achieve the voltage required to a sustained (>50 $\mu s)$ current limit during the box | | | | |
| 2 | BATUVL | 0 | RC | A "1" indicates that the battery voltage fell bel $V_{BAT} < UVLO_{BST}$ when the boost is first enable | low UVLO _{BST} during boost operation or that led. | | | |
| 1 | BSTWDTTO | 0 | RC | A "1" indicates the 100sec Watch Dog Timer | has timed out during Boost Operation. | | | |
| 0 | VBATLV | 0 | RC | Provides an interrupt bit for indicating that the battery has fallen below 3.0 V during Bo Operation. Boost operation will continue until either BOOSTEN = "0" or V_{BAT} < UVLO | | | | |
| | INT | 2 | • | Register Address: 06h | Default Value = 0000 0000 | | | |
| Bit | Name | Value | Туре | Description | | | | |
| 7 | ТОСМР | 0 | RC | A "1" indicates that Top–Off charging has completed with the expiration of the Top–Off timer when both TE="1" and TOEN="1". | | | | |
| 6 | OVPINPUT | 0 | RC | A "1" indicates that the V_{BUS} or V_{IN} voltage has risen above or fallen below the OVP threshold. See INPUTOVP (REG 02h[6]) Status bit. | | | | |
| 5 | SHORTBAT | 0 | RC | A "1" indicates that V_{BAT} has fallen below V_{SH} | HORT during charging. | | | |
| 4 | ICTEMP | 0 | RC | A "1" indicates that the IC temperature has risen high enough to trigger Thermal Regula- tion (T _{REGTH}), or Thermal Shutdown (T _{SHUTDOWN}). If ICTEMP = "1", see TEMPFB (REG 02h[4]) and TEMPSD (REG 02h[5]) Status bits to determine if the device is in Thermal Regulation or Thermal Shutdown. | | | | |
| 3 | BATTEMP | 0 | RC | A "1" indicates that the battery temperature ha If BATTEMP = "1", see NTC (REG 18h[5:0]) f | - | | | |
| 2 | OTGOCP | 0 | RC | A "1" indicates that the boost did not success | fully pass the Short Check State. | | | |
| 1 | BATOCP | 0 | RC | A "1" indicates that the BATFET (Q4) has exc | eeded its discharge current limit. | | | |
| 0 | TIMER | 0 | RC | If running from the Safety Timer, a "1" indicates that the safety timer for Pre-Charge or Fast Charge has expired. See TMRTO (REG 02h[0]) Status bit. If running from the Watch Dog Timer, a "1" indicates that the watch dog timer has expired in boost or charge operation. | | | | |
| | MINT | 0 | • | Register Address: 08h | Default Value = 0000 0000 | | | |
| Bit | Name | Value | Туре | Description | | | | |
| 7 | MVALFAIL | 0 | R/W | Writing a "1" masks VALFAIL = "1" from driving the /INT pin LOW. | | | | |
| 6 | MVININT | 0 | R/W | Writing a "1" masks VININT = "1" from driving the /INT pin LOW. | | | | |
| 5 | MVBUSINT | 0 | R/W | Writing a "1" masks VBUSINT = "1" from driving the /INT pin LOW. | | | | |
| 4 | MVLOWTH | 0 | R/W | Writing a "1" masks LOWTH = "1" from driving the /INT pin LOW. | | | | |
| 3 | MCHGEND | 0 | R/W | Writing a "1" masks CHGEND = "1" from driving the /INT pin LOW. | | | | |
| 2 | MCHGMOD | 0 | R/W | Writing a "1" masks CHGMOD = "1" from driving the /INT pin LOW. | | | | |
| 1 | MWKBAT | 0 | R/W | Writing a "1" masks WKBAT = "1" from driving the /INT pin LOW. | | | | |
| 0 | MBATINT | 0 | R/W | Writing a "1" masks BATINT = "1" from driving | g the /INT pin LOW. | | | |

Table 24. I²C REGISTER DESCRIPTIONS (continued)

| | MINT | 1 | | Register Address: 09h | Default Value = 0000 0000 | | |
|-----|-----------|-------|------|---|--|--|--|
| Bit | Name | Value | Туре | Description | | | |
| 7 | MIBATLO | 0 | R/W | Writing a "1" masks IBATLO = "1" from driving the /INT pin LOW. | | | |
| 6 | MRCHGN | 0 | R/W | Writing a "1" masks RCHGN = "1" from driving | g the /INT pin LOW. | | |
| 5 | MBSTOVP | 0 | R/W | Writing a "1" masks BSTOVP = "1" from driving the /INT pin LOW. | | | |
| 4 | MBSTTSD | 0 | R/W | Writing a "1" masks BSSTSD = "1" from driving the /INT pin LOW. | | | |
| 3 | MBSTFAIL | 0 | R/W | Writing a "1" masks BSTFAIL = "1" from driving the /INT pin LOW. | | | |
| 2 | MBATUVL | 0 | R/W | Writing a "1" masks BATULV = "1" from drivin | g the /INT pin LOW. | | |
| 1 | Reserved | 0 | R | | | | |
| 0 | MVBATLV | 0 | R/W | Writing a "1" masks VBATLV = "1" from driving | g the /INT pin LOW. | | |
| | MINT | 2 | | Register Address: 0Ah | Default Value = 0000 0000 | | |
| Bit | Name | Value | Туре | Description | | | |
| 7 | MTOCMP | 0 | R/W | Writing a "1" masks TOCMP = "1" from driving | g the /INT pin LOW. | | |
| 6 | MOVPINPUT | 0 | R/W | Writing a "1" masks OVPINPUT = "1" from dri | iving the /INT pin LOW. | | |
| 5 | MSHORTBAT | 0 | R/W | Writing a "1" masks SHORTBAT = "1" from dr | riving the /INT pin LOW. | | |
| 4 | MICTEMP | 0 | R/W | Writing a "1" masks ICTEMP = "1" from drivin | g the /INT pin LOW. | | |
| 3 | MBATTEMP | 0 | R/W | Writing a "1" masks BATTEMP = "1" from driving the /INT pin LOW. | | | |
| 2 | MOTGOCP | 0 | R/W | Writing a "1" masks OTGOCP = "1" from driving the /INT pin LOW. | | | |
| 1 | MBATOCP | 0 | R/W | Writing a "1" masks BATOCP = "1" from driving the /INT pin LOW. | | | |
| 0 | MTIMER | 0 | R/W | Writing a "1" masks TIMER = "1" from driving the /INT pin low if CONT = "1" (REG 0Eh [7]). If CONT = "0", MTIMER will be reset to "0" when a Pre-Charge or Fast Charge timer expires and will, therefore, not mask /INT bit. | | | |
| | CONTR | OL 0 | | Register Address: 0Ch | Default Value = 0011 1111 | | |
| Bit | Name | Value | Туре | Descr | iption | | |
| 7:6 | Reserved | 00 | R | | | | |
| 5:3 | VLOWV | 111 | R/W | This sets the good battery voltage threshold of er is available to the user. Binary V_{LOWV} (V) 000 3.0 001 3.1 010 3.2 011 3.3 100 3.4 101 3.5 110 3.6 111 3.7 | on the BAT pin, above which full system pow- | | |
| 2:0 | VBATMIN | 111 | R/W | This sets the voltage threshold on the BAT pin VBATMIN should not be set lower than the m Binary V_{BATmin} (V) 000 2.7 001 2.8 010 2.9 011 3.0 100 3.1 101 3.2 110 3.3 111 3.4 | | | |

Table 24. I²C REGISTER DESCRIPTIONS (continued)

| CONTROL 1 | | | | Register Address: 0Dh | Default Value = 0101 0111 | | |
|-----------|----------|-------|------|--|--|--|--|
| Bit | Name | Value | Туре | Descri | ption | | |
| 7 | GPO2 | 0 | R/W | A "1" enables GPO2 to output logic high. GPO2 is sourced by the LDO. (FAN54511A, FAN54511AP, FAN54513A only) | | | |
| 6 | GPO1 | 1 | R/W | A "1" enables GPO1 to output logic high. GPO1 is sourced by the LDO. (FAN54511A, FAN54511AP, FAN54513A only) | | | |
| 5 | LDO_OFF | 0 | R/W | A "1" disables the LDO. | | | |
| 4:3 | VLDO | 10 | R/W | Sets the LDO output voltage. The LDO input is sourced from PMID. Binary V _{LDO} (V) 00 3.30 01 3.60 10 4.95 11 5.05 | | | |
| 2 | Reserved | 1 | R | | | | |
| 1:0 | VSYS | 11 | R/W | $\begin{array}{llllllllllllllllllllllllllllllllllll$ | m required system voltage. With limited | | |
| | CONTR | IOL2 | | Register Address: 0Eh | Default Value = 0001 1100 | | |
| Bit | Name | Value | Туре | Descri | ption | | |
| 7 | CONT | 0 | w | Writing a "1" ignores a Pre-Charge or Fast Cł lows the IC to continue charging. However, th TIMER (REG 06h[0]) interrupt bit will still be s A "0" will reset all registers except SAFETY al the Pre-Charge or Fast Charge Safety Timer CONT does not affect the watchdog timer or t "0". | e TMRTO (REG 02h[0]) status bit and et to "1" upon timer expiration. nd put the charger IC into IDLE State when expires. | | |
| 6 | Reserved | 0 | R | | | | |
| 5 | RCHGDIS | 0 | R/W | Writing a "1" disables the automatic recharge age falls below $V_{FLOAT}-V_{RCHG}. \label{eq:constraint}$ | function with TE = "1" when the battery volt- | | |
| 4 | NOBATOP | 1 | R/W | For a "0", if no battery is detected during sour- charge) is reached, the charger will not perfor buck converter will stay on and the BATFET to tinue to run with no battery. For a "1" if no battery is detected during source charge) is reached, the charger will perform a battery is connected. The buck converter will ing the host processor to continue to run with | m an additional battery absence test. The urns off allowing the host processor to con- re plug-in or when a Full Battery (end of battery absence test every 2 seconds until a stay on and the BATFET (Q4) turns off allow- | | |
| 3 | TE | 1 | R/W | A "1" enables charge current termination and a "0" allows charging to continue even if I_{BAT} < I_{TERM} | | | |
| 2 | TOEN | 1 | R/W | A "1" enables the Top-Off charging. | | | |
| | | | | A "1" puts the IC in the High–Z state. This bit will be ignored when BOOSTEN = "1", bu device will return to HZ state when BOOSTEN is set back to "0". The bit will reset to "0" when V _{BAT} falls below V _{BATMIN} . When V _{BAT} < V _{BATMIN} , writes to this bit are ignored. | | | |
| 1 | HZMODE | 0 | R/W | | | | |

Table 24. I²C REGISTER DESCRIPTIONS (continued)

| | CONTR | OL3 | | Register Address: 0Fh | Default Value = 0100 0000 | | |
|-----|----------|-------|------|---|------------------------------------|--|--|
| Bit | Name | Value | Туре | Description | | | |
| 7 | RESET | 0 | R/W | Writing a "1" resets all registers to their defau Read returns "0". | lts: writing a "0" has no effect. | | |
| 6:5 | TREGTH | 10 | R/W | Temperature threshold at which the current is overheating. Binary T _{REGTH} (°C) 00 70 01 85 10 100 11 120 | reduced to prevent the device from | | |
| 4:3 | Reserved | 0 | R | | | | |
| 2 | PPOFFSLP | 0 | R/W | PPOFFSLP is for automatic Ship Mode entry once the input source (VBUS or VIN) is removed. When PPOFFSLP is set to a "1", PPOFF will be automatically written to "1" when V_{BUS} or V_{IN} falls below $V_{SOURCE(FALL)}$. PPOFFSLP will be reset to "0" once a valid input power source is connected. | | | |
| 1 | PPOFF | 0 | R/W | Writing a "1" to this bit turns the BATFET (Q4) off immediately. While PPOFF is set to "1", supplemental mode is not allowed. Bit Reset Behavior PPOFFSLP = "1" (Ship Mode): PPOFF and PPOFFSLP will be reset to "0" when a valid input source is connected. PPOFFSLP="0": PPOFF will be reset to "0" when a valid input source is either removed or connected. | | | |
| 0 | CE# | 0 | R/W | During a normal charging condition, a "0" ena BATFET (Q4) but will allow the battery to sup $V_{BAT}\!\!\!\!\!\!$ | | | |

Table 24. I²C REGISTER DESCRIPTIONS (continued)

| Name Value Type | | Default Value=0110 1001 | | |
|--------------------|--|-------------------------|--|--|
| Name Value Type | Description | | | |
| Charger output "fl | $\begin{array}{c} \text{at'' voltage, } V_{\text{FLOAT.}} \\ \text{m 3.3 V to 4.72 V in 10 mV i} \\ \hline \\ \text{Hex} & V_{\text{FLOAT}}(\text{V}) \\ 37 & 3.85 \\ 38 & 3.86 \\ 39 & 3.87 \\ 3A & 3.88 \\ 3B & 3.89 \\ 3C & 3.90 \\ 3D & 3.91 \\ 3E & 3.92 \\ 3F & 3.93 \\ 40 & 3.94 \\ 41 & 3.95 \\ 42 & 3.96 \\ 43 & 3.97 \\ 44 & 3.98 \\ 45 & 3.99 \\ 46 & 4.00 \\ 47 & 4.01 \\ 48 & 4.02 \\ 49 & 4.03 \\ 4A & 4.04 \\ 48 & 4.02 \\ 49 & 4.03 \\ 4A & 4.04 \\ 4B & 4.05 \\ 4C & 4.06 \\ 4D & 4.07 \\ 4E & 4.08 \\ 4F & 4.09 \\ 50 & 4.10 \\ 51 & 4.11 \\ 52 & 4.12 \\ 53 & 4.13 \\ 54 & 4.14 \\ 55 & 4.15 \\ 56 & 4.16 \\ \end{array}$ | | | |

Table 24. I²C REGISTER DESCRIPTIONS (continued)

| | IOCHI | RG | | Register Address: 12h | Default Value=0001 0000 | | | |
|-----|----------|--------|------|---|---|--|--|--|
| Bit | Name | Value | Туре | Description | | | | |
| 7:6 | Reserved | 00 | R | | | | | |
| | | | | Sets the typical battery charging current, I _{OCHRG} , during Fast Charging. Programmable from 0.200 A to 3.200 A in 50 mA increments. Default is 1.000 A. | | | | |
| 5:0 | IOCHRG | 010000 | R/W | $\begin{array}{c c c c c c c c c c c c c c c c c c c $ | Hex I _{OCHRG} (A) 2A 2.300 2B 2.350 2C 2.400 2D 2.450 2E 2.500 2F 2.550 30 2.660 31 2.650 32 2.700 33 2.750 34 2.800 35 2.850 36 2.900 37 2.950 38 3.000 39 3.050 3A 3.100 3B 3.150 3C 3.200 | | | |
| | | | | Bits 3Dh – 3 | Fh = 3.200 A | | | |
| | IBA | Г | L | Register Address: 13h | Default Value = 1001 1000 | | | |
| Bit | Name | Value | Туре | Descr | iption | | | |
| | | | | Sets the termination current threshold, I_{TERM} . Programmable from 100 mA to 600 mA. Defa If TE = "1" and the charge current falls below will stop. | ult is 300 mA. | | | |
| 7:4 | ITERM | 1001 | R/W | Binary I _{TERM} (A) 0000 Reserved 0001 Reserved 0010 Reserved 0011 0.100 0100 0.125 0101 0.150 0110 0.175 0111 0.200 | Binary I _{TERM} (A) 1000 0.250 1001 0.300 1010 0.350 1011 0.400 1100 0.450 1101 0.500 1110 0.550 1111 0.600 | | | |
| | | | | Sets the typical battery charging current, I _{PP} , Programmable from 200 mA to 800 mA. Defa | during Pre-Charge Mode. ult is 450 mA. | | | |
| 3:0 | PRECHG | 1000 | R/W | Binary Ipp (A) 0000 Reserved 0001 Reserved 0010 Reserved 0011 0.200 0100 0.250 0101 0.300 0110 0.350 0111 0.400 | $\begin{array}{cccc} Binary & I_{PP}\left(A\right) \\ 1000 & 0.450 \\ 1001 & 0.500 \\ 1010 & 0.550 \\ 1011 & 0.600 \\ 1100 & 0.650 \\ 1101 & 0.700 \\ 1110 & 0.750 \\ 1111 & 0.800 \\ \end{array}$ | | | |

Table 24. I²C REGISTER DESCRIPTIONS (continued)

| | IBU | S | | | Register A | ddress: | 14h | | Default Value | e = 0001 | 0000 |
|-----|----------|---------|------|--|---|--|--|---|--|--|----------------------------------|
| Bit | Name | Value | Туре | | | | Desci | ription | | | |
| 7 | Reserved | 0 | R | | | | | | | | |
| 6:0 | IBUSLIM | 0010000 | R/W | Program There a 23h (97 table fo Hex 00 01 02 03 04 05 06 07 08 09 0A 08 09 0A 0B 0C 0D 0E 0F 10 11 12 13 14 | nmable from 1 tre 3 FET segr 5 mA), and 24 r the associate I _{BUSLIM} (A) 0.100 0.125 0.150 0.175 0.200 0.225 0.250 0.275 0.300 0.325 0.350 0.375 0.400 0.425 0.450 0.450 0.450 0.455 0.550 0.555 0.550 0.575 0.600 | 00 mA t nentatio th (1000 ed R _{DS} (C 1D 1E 20 21 22 23 24 25 26 27 28 29 2A 28 29 2A 28 29 2A 22 20 22 23 31 | o 3.00 A in 25 r n ranges: 00h (mA) to 7Fh (30 N) values. IBUSLIM (Å) 0.825 0.850 0.875 0.900 0.925 0.950 0.950 0.955 1.000 1.025 1.050 1.025 1.100 1.125 1.150 1.175 1.200 1.225 1.250 1.225 1.250 1.225 1.300 1.325 | nA steps 100 mA) 000 mA) Hex 3A 3B 3C 3B 3C 3B 3C 3B 3C 3B 40 41 42 43 44 45 46 47 48 49 44 45 46 47 48 40 44 45 | om the VBUS in s. Default is 500 to 08h (300 m Refer to the E IBUSLIM (Å) 1.550 1.575 1.600 1.625 1.650 1.675 1.700 1.725 1.750 1.775 1.800 1.825 1.850 1.875 1.900 1.925 1.950 1.975 2.000 2.025 2.050 | 0 mA. A), 09h lectrical Hex 57 58 59 55 55 55 55 55 55 55 55 55 55 60 61 62 64 65 66 67 68 69 6A 66 66 66 66 66 | Specifications |
| | | | | 15 16 17 18 | 0.625 0.650 0.675 0.700 | 32 33 34 35 | 1.350 1.375 1.400 1.425 | 4F 50 51 52 | 2.075 2.100 2.125 2.150 | 6D 6E 6F 70 | 2.825 2.850 2.875 2.900 |
| | | | | 19 1A 1B 1C | 0.725 0.750 0.775 0.800 | 36 37 38 39 | 1.450 1.475 1.500 1.525 | 53 54 55 56 | 2.175 2.200 2.225 2.250 | 71 72 73 74 | 2.925 2.950 2.975 3.000 |
| | | | | | | <u> </u> | Bits 75h – 7 | | | <u> </u> | |

Table 24. I²C REGISTER DESCRIPTIONS (continued)

| | VBU | S | | Register Address: 15h | Default Value = 0010 0100 |
|-----|----------|-------|------|--|---------------------------|
| Bit | Name | Value | Туре | Desc | ription |
| 7:6 | Reserved | 00 | R | | |
| 5:4 | VBUSOVP | 10 | R/W | This sets the V _{BUS_OVP} threshold. Binary V _{BUS_OVP} (V) 00 6.5 01 10.5 10 13.7 11 Reserved | |
| 3:0 | VBUSLIM | 0100 | R/W | $\begin{array}{llllllllllllllllllllllllllllllllllll$ | |

Table 24. I²C REGISTER DESCRIPTIONS (continued)

| | IIN | | | Register A | ddress: 16h | | | Default Value = 0001 1011 |
|-----|----------|---------|------|--|--|------------|----------|---------------------------|
| Bit | Name | Value | Туре | Description | | | | |
| 7 | Reserved | 0 | R | | | | | |
| 6:0 | IINLIM | 0011011 | R/W | This sets the maximu Programmable from 3 Hex I _{INLIM} (A) 00 0.325 01 0.350 02 0.375 03 0.400 04 0.425 05 0.450 06 0.475 07 0.500 08 0.525 09 0.550 0A 0.575 0B 0.600 0C 0.625 0D 0.650 0E 0.675 0F 0.700 10 0.725 11 0.750 12 0.775 13 0.800 14 0.825 15 0.850 16 0.875 17 0.900 18 0.925 19 0.950 1A 0.975 1B 1.000 1C 1.025 | 325 mA to 2 A Hex I _{II} 1D 1. 1F 1. 20 1. 21 1. 22 1. 23 1. 24 1. 25 1. 26 1. 27 1. 28 1. 27 1. 28 1. 29 1. 28 1. 27 1. 28 1. 27 1. 28 1. 27 1. 30 1. 31 1. 31 1. 33 1. 34 1. 35 1. 37 1. 38 1. 38 1. 38 1. 38 1. 34 1. 35 1. 37 1. 38 1. 38 1. 38 1. 38 1. 30 1. 31 1. 32 1. 33 1. 34 1. 35 1. 37 1. 38 1. 38 1. 38 1. 38 1. 31 1. 32 1. 33 1. 34 1. 35 1. 37 1. 38 1. 38 1. 38 1. 31 1. 32 1. 31 1. 32 1. 31 1. 31 1. 33 1. 34 1. 35 1. 37 1. 38 1. 38 1. 38 1. 38 1. 38 1. 31 1. 31 1. 32 1. 33 1. 34 1. 35 1. 37 1. 38 1. 38 1. 38 1. 38 1. 38 1. 31 1. 31 1. 31 1. 31 1. 31 1. 31 1. 31 1. 31 1. 33 1. 34 1. 35 1. 37 1. 38 1. 38 1. 31 1. 31 1. 32 1. 33 1. 34 1. 35 1. 37 1. 38 1. 31 1. 31 1. 32 1. 33 1. 34 1. 35 1. 38 1. 37 1. 38 1. 38 1. 31 1. 31 1. 32 1. 33 1. 34 1. 35 1. 37 1. 38 1. 38 1. 31 1. 31 1. 31 1. 31 1. 33 1. 31 1. 33 1. 33 1. 33 1. 34 1. 35 1. 37 1. 38 1. 31 1. 31 1. 31 31 1. 33 1. 31 31 1. 33 1. 31 31 1. 33 1. 31 31 1. 33 1. 33 1. 33 1. 33 1. 33 1. 33 1. 34 1. 35 1. 38 1. 31 1. 31 1. 31 1. 31 1. 31 31 1. 31 31 1. 33 1. 33 1. 33 1. 34 1. 35 1. 38 1. 31 1. 31 1. 31 31 1. 31 1. 3 | | | |
| | | | | | Bit | ts 44h – 7 | Fh = 2.0 | 00 A |

Table 24. I²C REGISTER DESCRIPTIONS (continued)

| | VIN | l | | Register Address: 17h | Default Value = 0001 0100 |
|-----|----------|-------|------|---|--|
| Bit | Name | Value | Туре | Descri | ption |
| 7:6 | Reserved | 00 | R | | |
| 5:4 | VINOVP | 01 | R/W | This sets the V _{IN_OVP} threshold. Binary V _{IN_OVP} (V) 00 6.5 01 10.5 10 13.7 11 Reserved | |
| 3:0 | VINLIM | 0100 | R/W | Binary VINLIM (V) 0000 4.240 0001 4.320 0010 4.400 0011 4.480 0100 4.560 0101 4.640 0110 4.560 0101 4.640 0110 4.720 0111 4.800 1000 7.632 1001 7.776 1010 7.920 1011 8.064 1100 8.208 1101 8.352 1110 8.496 1111 8.640 | namic Input Voltage Control loop will regu- limited weak adapter is connected to VIN. |
| | NTC | > | • | Register Address: 18h | Default Value = 0000 1111 |
| Bit | Name | Value | Туре | Descri | ption |
| 7:6 | Reserved | 00 | R | | |
| 5 | TEMPDIS | 0 | R/W | This controls whether the NTC circuit affects the surements will continue to be updated every 1BinaryNTC Operation0NTC measurement affects charge p1NTC measurement does not affect of the surement does not affe | second in the NTC1 – 4 monitor bits. arameters |
| 4 | NTCOK | 0 | R | "0" if NTC is either shorted to ground, open or | shorted to REF. |
| 3 | NTC4 | 1 | R | A "1" indicates that NTC is above the T4 thres | hold. (Note 14) |
| 2 | NTC3 | 1 | R | A "1" indicates that NTC is above the T3 thres | hold. (Note 14) |
| | NTC2 | 1 | R | A "1" indicates that NTC is above the T2 thres | hold. (Note 14) |
| 1 | | | | | |

Table 24. I²C REGISTER DESCRIPTIONS (continued)

| | TIME | R | | Register Address: 1 | 9h | Default Value = 0001 1011 |
|-----|----------|-------|------|--|--|--|
| Bit | Name | Value | Туре | | Descri | ption |
| 7 | TMRRST | 0 | W | Writing a "1" resets the Watch I Reading this bit always returns | Dog Timer; writ "0". | ing a "0" has no effect. |
| 6 | WDEN | 0 | R/W | Writing a "1" enables the Watch | ndog timer (t _{WD} |) and disables the Safety timer. |
| 5 | Reserved | 0 | R | | | |
| | | | | These bits set the Pre-Charge SETTMR0 (REG 1Fh[0] must b is changed to restart the timer i | e set to "1" imr | nediately after the Pre-Charge timer value ned configuration. |
| 4:3 | PRETMR | 11 | R/W | BinaryPre-Charge Safety T00Follows FCTMR (REI01100 seconds1015 minutes1136 minutes | | ogramming |
| | | | | This sets the Fast Charge safet | ty timer. | |
| 2:0 | FCTMR | 011 | R/W | Binary Fast Charge Safety T 000 Never Expires 001 4 010 6 011 8 100 10 101 12 110 14 111 16 | īmer (Hours) | |
| | SAFETY | | | Register Address: 1 | Ah | Default Value = 1111 1111 |
| Bit | Name | Value | Туре | | Descri | ption |
| 7:4 | VSAFE | 1111 | R/W | $\begin{array}{c c} \mbox{These bits set the maximum problem} \\ \hline \mbox{Binary} & V_{\mbox{FLOAT}} \mbox{Max. (Hex)} \\ 0000 & 00 \\ 0001 & 0A \\ 0010 & 14 \\ 0011 & 1E \\ 0100 & 28 \\ 0101 & 32 \\ 0101 & 32 \\ 0110 & 3C \\ 0111 & 46 \\ 1000 & 50 \\ 1001 & 5A \\ 1010 & 64 \\ 1011 & 6E \\ 1100 & 78 \\ 1101 & 82 \\ 1110 & 8C \\ 1111 & 8E - \mbox{FF} \end{array}$ | V _{FLOAT} Max 3.30 3.40 3.50 3.60 3.70 3.80 3.90 4.00 4.10 4.20 4.40 4.50 4.40 4.50 4.60 4.70 4.72 | |
| | | | | These bits set the maximum pro | ogrammable IC | DCHRG (REG 12h[5:0]) value. |
| 3:0 | ISAFE | 1111 | R/W | Binary I _{OCHRG} Max. (Hex) 0000 00 0001 04 0010 08 0011 0C 0100 10 0101 14 0110 18 0111 1C 1000 20 1001 24 1010 28 1011 2C 1100 30 1101 34 1111 3C | I _{OCHRG} Max 0.20 0.40 0.60 0.80 1.00 1.20 1.40 1.60 1.80 2.00 2.20 2.40 2.60 2.80 3.00 3.20 | x. (A) |

Table 24. I²C REGISTER DESCRIPTIONS (continued)

| | ТОРО | FF | | Register Address: 1Bh | Default Value = 0000 0011 | |
|-----|------------|--------|------|--|--|--|
| Bit | Name | Value | Туре | Desci | iption | |
| 7:4 | Reserved | 0000 | R | | | |
| 3 | TO_BDETDIS | 0 | R/W | Setting this bit "1" disables the periodic batter | ry check during top-off charging. | |
| 2:0 | TOTMR | 011 | R/W | This sets the Top-Off charge timer. Binary Top Off Timer (min.) 000 Never Expires 001 10 010 20 011 30 100 40 101 50 110 60 111 70 | | |
| | BOOS | ST | | Register Address: 1Ch | Default Value = 0001 0010 | |
| Bit | Name | Value | Туре | Desci | iption | |
| 7 | Reserved | 0 | R | | | |
| 6 | отд | 0 | R/W | Connects PMID to VBUS when the boost is enabled (BOOSTEN = "1"). This will reset when BOOSTEN = "0". | | |
| 5 | BOOSTEN | 0 | R/W | This programs the operation of the switch-m fault occurs during boost mode the BOOSTE BOOSTEN Switch-Mode Converter 0 Charge Mode 1 Boost Mode | N bit and the OTG bit will reset. | |
| 4 | Reserved | 1 | R | | | |
| 3:0 | VBOOST | 0010 | R/W | $\begin{array}{llllllllllllllllllllllllllllllllllll$ | V _{BOOST} . .67 mV steps. Default is 5.00 V. | |
| | DPLU | IS | 1 | Register Address: 1Fh | Default Value = 0000 0000 | |
| Bit | Name | Value | Туре | Desci | iption | |
| 7 | FORCEDET | 0 | R/W | Setting this bit to "1" forces a BC1.2 detection | n on D+ and D | |
| 6:1 | Reserved | 000000 | R | | | |
| 0 | SETTMR0 | 0 | w | While operating on the Safety Timer a "1" res SETTMR0 must be set to "1" immediately aft 19h [4:3]) value is changed in order to restart Reading this bit always returns "0". | er the Pre-Charge timer (PRETMR (REG | |

Table 24. I²C REGISTER DESCRIPTIONS (continued)

This table defines the operation of each register bit for all IC versions. Default values are with VBAT = 3.8 V and VBUS = VIN = open.

| | MONITO | DR 0 | | Register Address: 20h | Default Value = 1000 0110 | | |
|-----|-------------|--------|------|---|---|--|--|
| Bit | Name | Value | Туре | Description | | | |
| 7 | ITERMCMP | 1 | R | I _{TERM} comparator output: "1" when I _{BAT} > ITE | ERM reference or VBUS/ VIN not present. | | |
| 6 | VBATCMP | 0 | R | Output of VBAT comparator: "1" when V _{BAT} > | VBATMIN. | | |
| 5 | VLOWVCMP | 0 | R | Output of VLOWV comparator. In Fast Charge mode, a "1" indicates when $V_{BAT} > V_{LOWV}$. In Pre-Charge mode, a "1" indicates when $V_{SYS} > V_{BATMIN}$. In Boost mode, a "1" indicates when $V_{BAT} > VBATLV$ threshold. | | | |
| 4 | BATSHORT | 0 | R | A "1" indicates that $V_{BAT} > V_{SHORT}$ in any chacates that $V_{SYS} > UVLO_{BST}$. | arge mode or HZ. In Boost mode, a "1" indi- | | |
| 3 | HIVBAT | 0 | R | A "1" indicates that $V_{BAT} \ge V_{FLOAT}$ when char | rge termination, TE bit is set to "0". | | |
| 2 | IBUS# | 1 | R | A "0" indicates the I_{BUS} or I_{IN} loop is controlling | ng the battery charge current. | | |
| 1 | ICHG# | 1 | R | A "0" indicates the I _{OCHRG} loop is controlling | the battery charge current. | | |
| 0 | CV | 0 | R | A "1" indicates the constant-voltage (CV) loop is controlling the charger and all o loops have released. | | | |
| | MONITO | DR 1 | | Register Address: 21h | Default Value = 1010 0XXX | | |
| Bit | Name | Value | Туре | Descr | iption | | |
| 7 | Reserved | 1 | R | | | | |
| 6 | PMIDVBAT | 0 | R | A "1" indicates that V _{PMID} > V _{BAT} . | | | |
| 5 | PPON | 1 | R | A "1" if charging and $V_{BAT} > V_{SHORT}$ or if the | IC is in Standby or HZ. | | |
| 4 | BUCKON | 0 | R | A "1" indicates the buck converter is on. | | | |
| 3 | ISRCCMP | 0 | R | A "1" indicates that either V_{BUS} or V_{IN} has risen above $V_{SOURCE(RISE)}$ and is currently above $V_{SOURCE(RISE)}$. A "0" indicates that both V_{BUS} and V_{IN} are below $V_{SOURCE(FALL)}$. | | | |
| 2 | NTCGND | Х | R | A "1" indicates that the NTC pin was tied to g | round at V _{BUS} POR. | | |
| 1 | DISPIN | Х | R | A "1" indicates that the DIS pin has been exte | ernally driven HIGH. | | |
| 0 | ILIMPIN | Х | R | A "1" indicates that the ILIM pin has been exte | ernally driven HIGH. | | |
| | IC_INI | FO | | Register Address: 2Dh | Default Value = 10XX XXXX | | |
| Bit | Name | Value | Туре | Descr | iption | | |
| 7:6 | Vendor Code | 10 | R | Identifies ON Semiconductor as the IC suppli | er. | | |
| 5:3 | PN | XXX | R | Part numbers bits, see the Ordering Info in Ta | able 2. | | |
| 2:0 | REV | XXX | R | IC Revision | | | |
| | FEATURE C | ONTROL | | Register Address: 30h | Default Value = 0010 0000 | | |
| Bit | Name | Value | Туре | Descr | iption | | |
| 7 | WDTEXP | 0 | R/W | A "1" will reset all registers except SAFETY a the Watch Dog Timer (WDT) expires. | nd put the charger IC into IDLE State when | | |
| 6 | Reserved | 0 | R | | | | |
| 5 | DIVCON | 1 | R/W | A "0" disables Dynamic Input Voltage Control (DIVC). | | | |
| 4 | DISREF | 0 | R/W | A "1" will disable the REF output and NTC functionality. JEITA not enforced. | | | |
| 3 | Reserved | 0 | R | | | | |
| 2 | Reserved | 0 | R | | | | |
| 1 | Reserved | 0 | R | | | | |
| 0 | Reserved | 0 | R | | | | |

14. Without power from VBUS or VIN, the reference will not be powered and the NTC pin will be at ground. See applications section for more detail.

PRODUCT-SPECIFIC DIMENSIONS (MM)

| Product | E | D | Х | Y |
|--------------|---------------------------------|------------------------|-------|-------|
| FAN5451xAUCX | $\textbf{3.63}\pm\textbf{0.03}$ | $\textbf{2.83}\pm0.03$ | 0.195 | 0.195 |





| DOCUMENT NUMBER: | 98AON13339G | Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. | | | | |
|---|----------------------------|---|-------------|--|--|--|
| DESCRIPTION: | WLCSP63 3.63x2.83x0.522 PA | | PAGE 1 OF 1 | | | |
| ON Semiconductor and (11) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others. | | | | | | |

© Semiconductor Components Industries, LLC, 2019

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor date sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use a a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor houteds for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

ON Semiconductor Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800–282–9855 Toll Free USA/Canada Phone: 011 421 33 790 2910 Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative